

MEG status

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Lecce – 27/06/2013

Obiettivo dell'esperimento

- L'esperimento MEG ha lo scopo di misurare il rapporto di decadimento

$$B = (\mu^+ \rightarrow e^+ \gamma) / (\mu^+ \rightarrow \text{tot})$$

al livello di circa 10^{-13} .

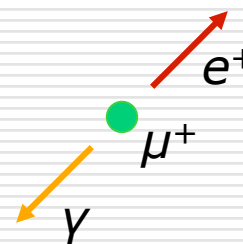
- Il modello standard prevede la conservazione del numero leptonico a tutti gli ordini. Anche includendo nel modello una massa dei neutrini diversa da zero, il nuovo modello prevede un rapporto B non accessibile sperimentalmente ($B < 10^{-40}$).
- Tuttavia alcune teorie di grande unificazione supersimmetrica prevedono un valore di B molto più grande ($10^{-14} \div 10^{-11}$). In questo senso MEG potrebbe fornire un utile contributo all'esplorazione della fisica oltre il modello standard.

Rivelazione

- La segnatura del decadimento

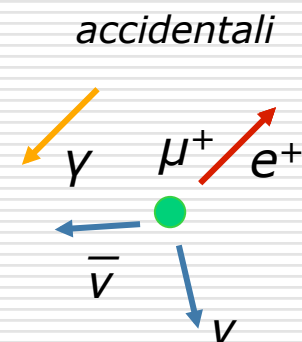
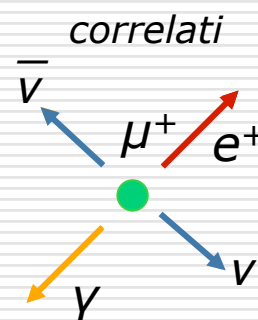
$$\mu^+ \rightarrow e^+ \gamma$$

è l'emissione della coppia $e^+ \gamma$, in direzioni opposte e con energia di circa 52.8 MeV, siccome il decadimento del μ^+ avviene a riposo.



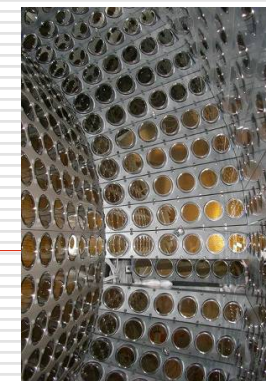
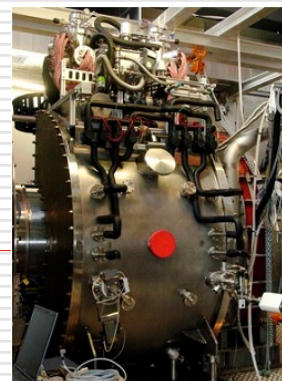
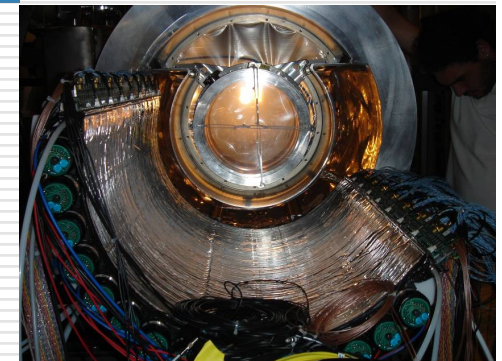
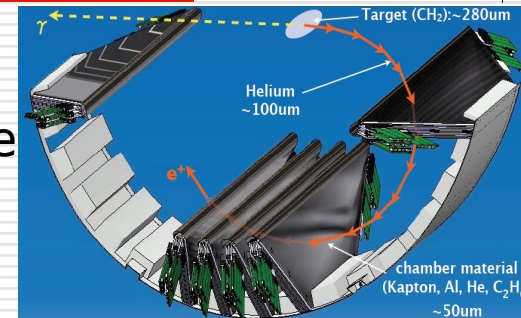
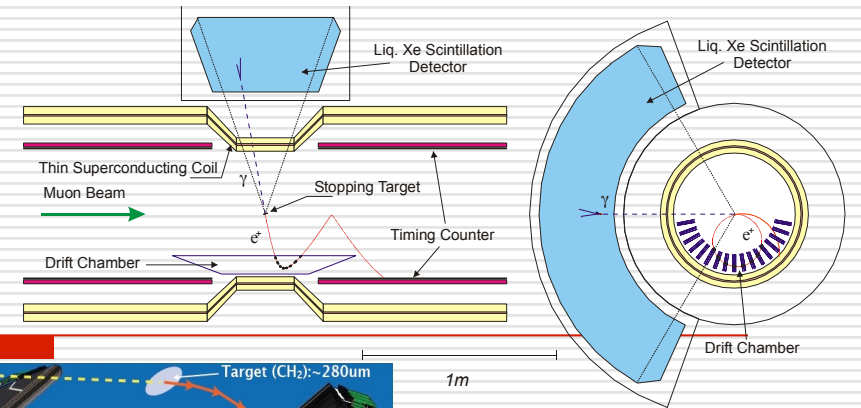
- Pertanto l'identificazione di questo processo necessita di una buona capacità di riconoscere le due particelle e una misura con elevata risoluzione delle loro energie, dell'angolo relativo e della contemporaneità della loro emissione.

- I fondi principali sono dovuti ai decadimenti radiativi del μ^+ e decadimenti di Michel col γ proveniente da altri processi



Lo Spettrometro

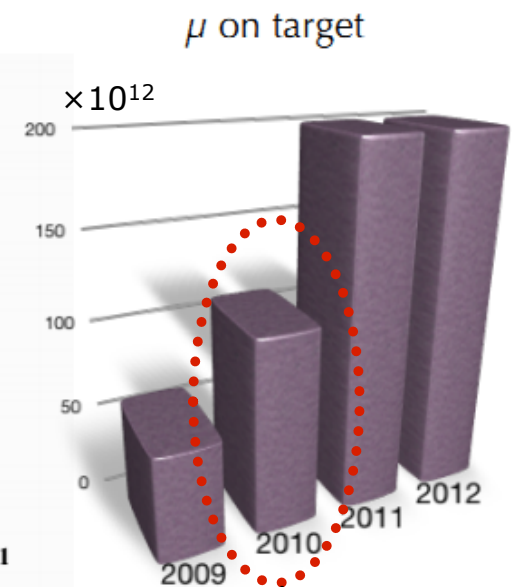
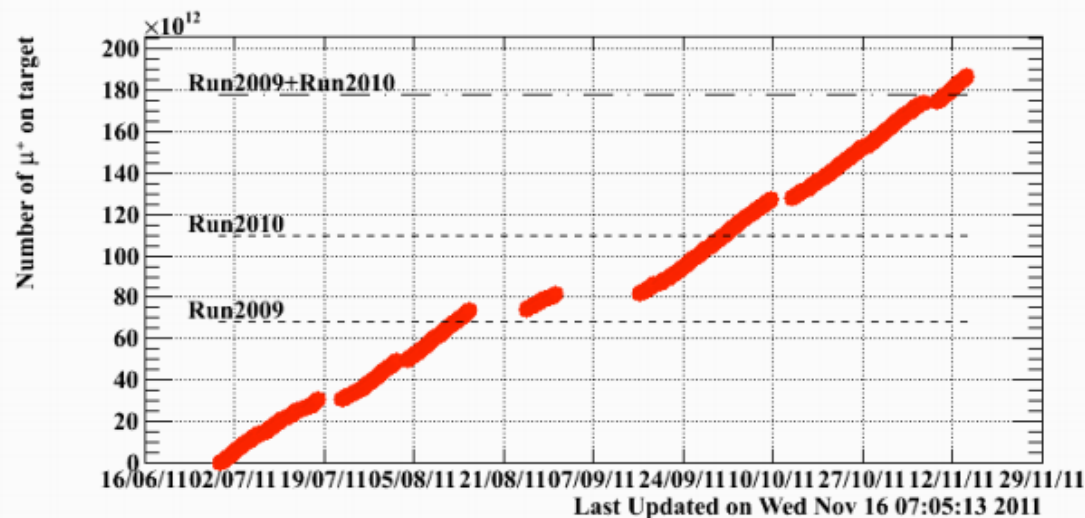
- Il fascio di muoni (circa $3 \times 10^7/\text{sec}$) viene arrestato su un bersaglio di polietilene spesso $150\mu\text{m}$
- La quantità di moto e la direzione di volo dei positroni sono determinati mediante un magnete superconduttore ed un tracciatore realizzato con un sistema di 16 camere a drift
- Il tempo di volo dei positroni è misurato da un sistema di scintillatori.
- Energia, posizione e tempo di volo dei fotoni sono determinati attraverso le scintillazioni prodotte in un calorimetro a Xe liquido.



Runs

- 3 anni di run (2009-2011) hanno permesso di migliorare di un fattore 5 il limite superiore sul decadimento cercato $[(\mu^+ \rightarrow e^+ \gamma) / (\mu^+ \rightarrow e^+ \nu \bar{\nu})]$ al 99% C.L.

■ 2009	→	9.6×10^{-12}
■ 2010	→	1.7×10^{-12}

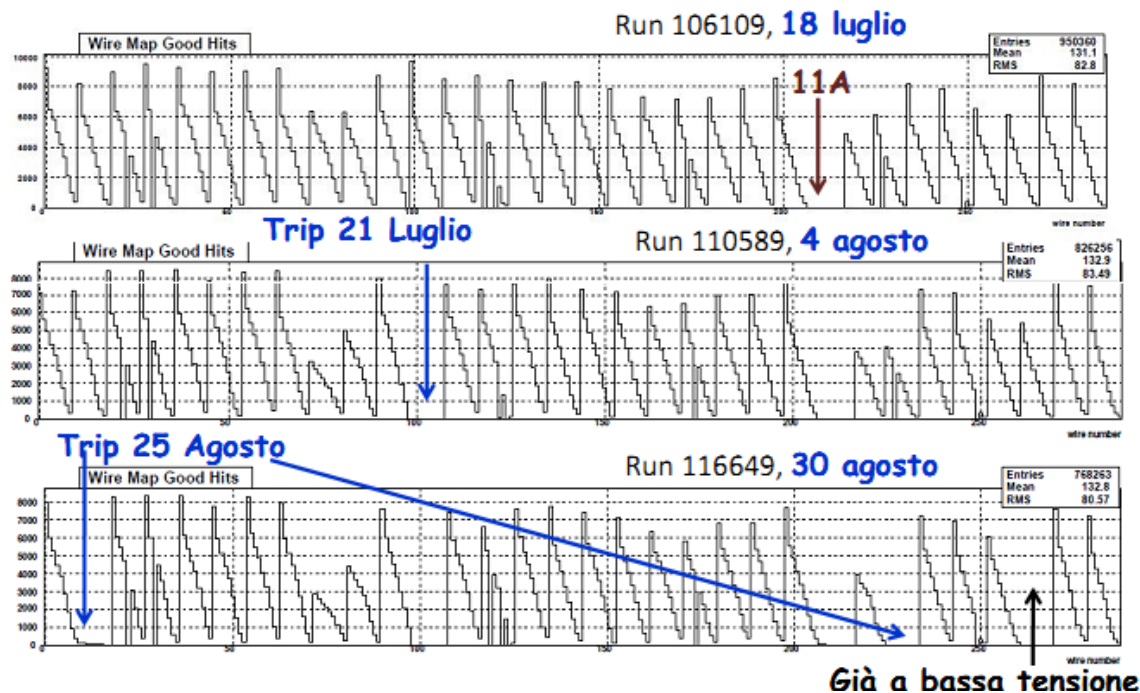


Meta statistica rispetto
Al 2011 a della rottura del
solenioide di trasporto del
fascio (BTS) 5

Tracciatore di positroni

- ❑ L'instabilità intrinseca del sistema di tracciamento ha inficiato in maniera consistente efficienze e risoluzioni spaziali
- ❑ A questo si è aggiunto il problema di disturbi rilevati dall'elettronica di FE ricondotti a possibili ground loop nei circuiti e mai completamente risolti
- ❑ Questo ha indotto la collaborazione a considerare la completa sostituzione del tracciatore con uno basato su un disegno differente

Numero di hits per filo in 3 diversi periodi.



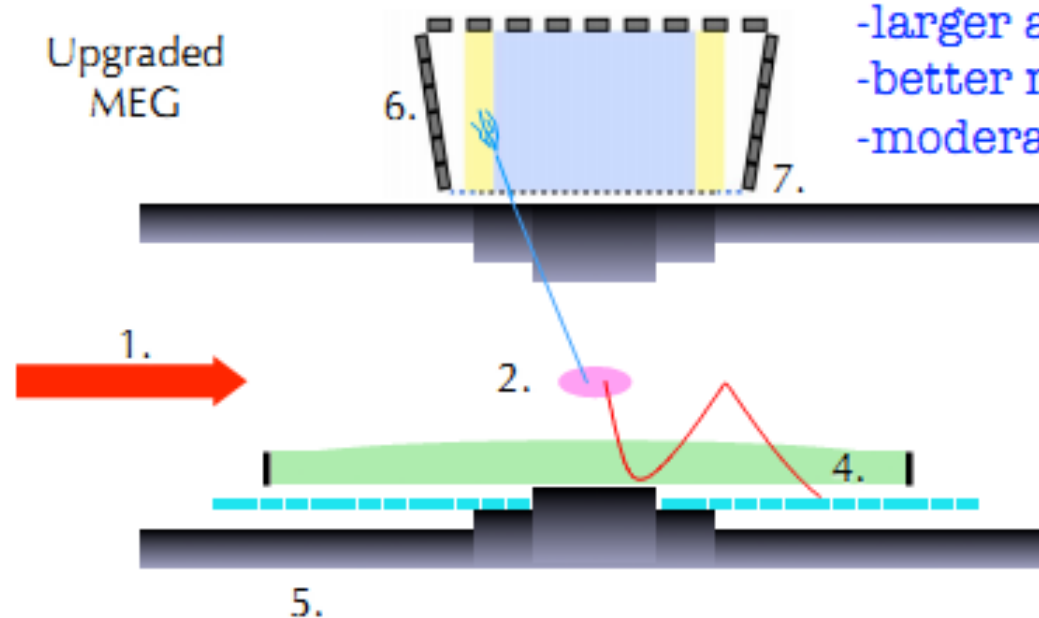
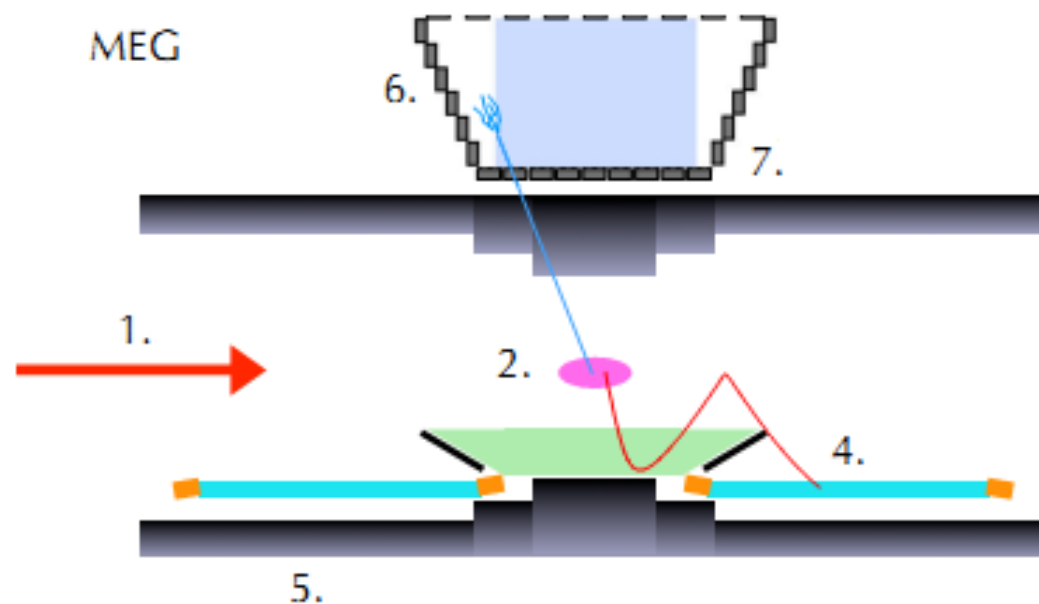
Variable	Previsto	Ottenuto
Photon Energy (%)	1.2	1.9
Photon timing (psec)	43	67
Photon position (mm)	4(u,v),6(w)	5(u,v),6(w)
Photon efficiency (%)	> 40	60
Positron momentum (KeV)	200	380
Positron angle (mrad)	$5(\phi_e)/5(\theta_e)$	$7(\phi_e)/9(\theta_e)$
Positron timing (psec)	50	107
Positron efficiency (%)	90	40
Relative angle (mrad)	7.2	10.3
Relative timing (psec)	65	120

Upgrade

□ La proposta di upgrade prevede

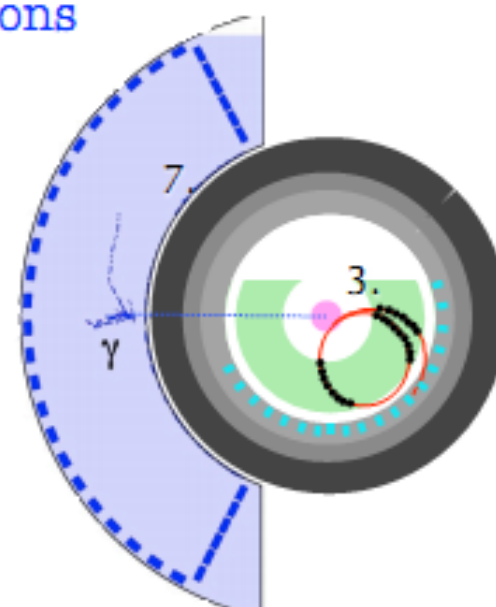
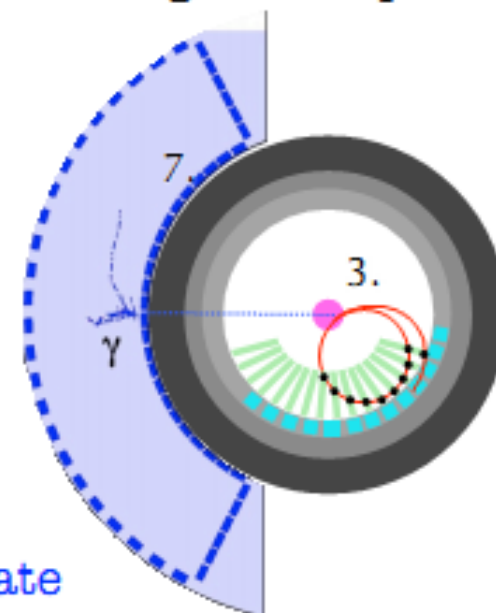
- Sostituzione del tracciatore con una DC a volume continuo
- Sostituzione dei PMT della faccia più interna del calorimetro LXe con SiPM (array di PMT da 1" quadrato), per migliorare la risoluzione nella posizione di arrivo del γ
- Realizzazione di un bersaglio attivo con fibre scintillanti singolarmente accoppiate a una matrice di SiPM, per migliorare la risoluzione nella posizione di arresto/decadimento del μ
- Uso di SiPM per la lettura degli scintillatori del TC (aumenta la risoluzione temporale, aumenta l'efficienza, riduce il pileup)

□ L'ultimo punto è ancora oggetto di discussione relativamente alla miglioria introdotta in relazione al costo



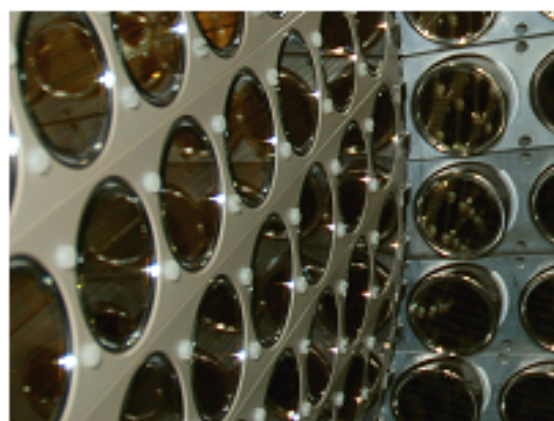
- higher beam rate
- larger acceptance
- better resolutions
- moderate cost

upgrade design based on
our long time experience



LXe Detector

- finer photon sensors at entrance face
- better uniformity - better resolution
- better handles for pile ups

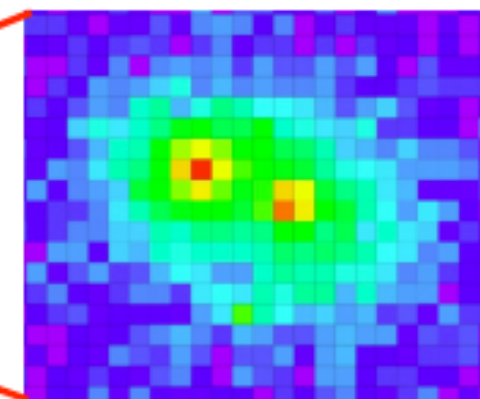
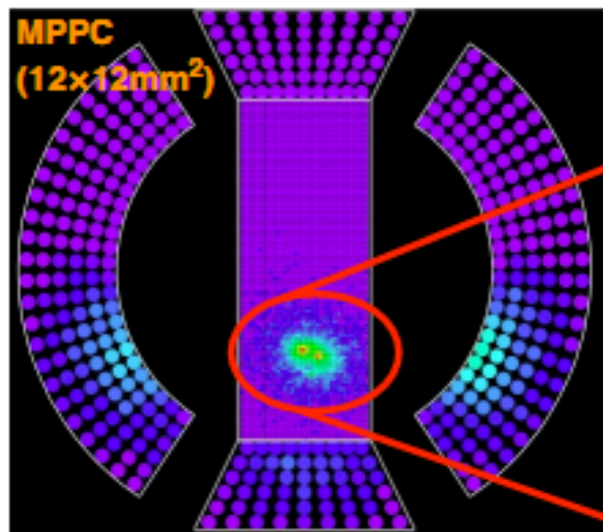
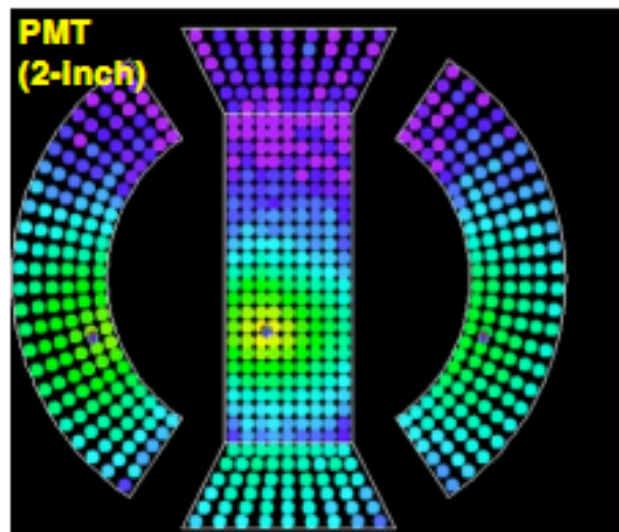


(a) Present detector



(b) Upgraded detector (CG)

LXe detector proved to work at 10^8 muons/s w/o pileup issues



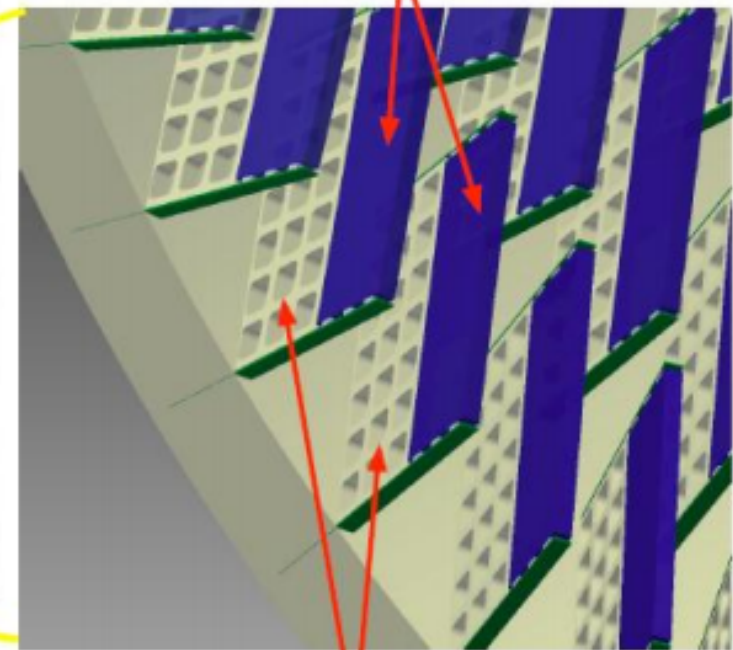
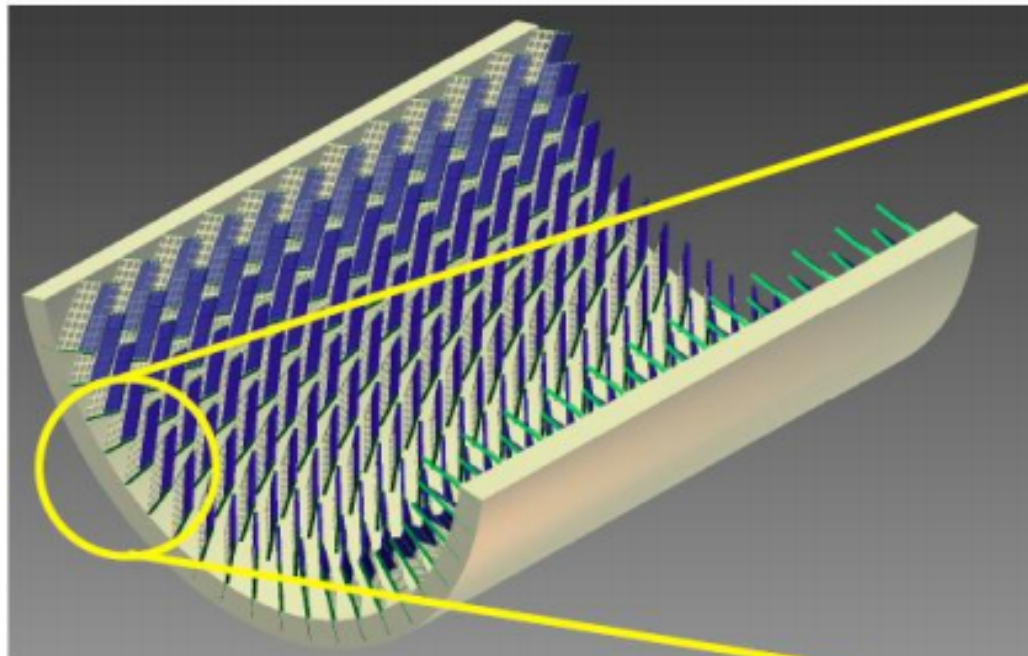
Concept of TC upgrade

• Pixelated scintillator detector

- Small scintillator plates
- Several hundreds of counters
- Readout by SiPMs



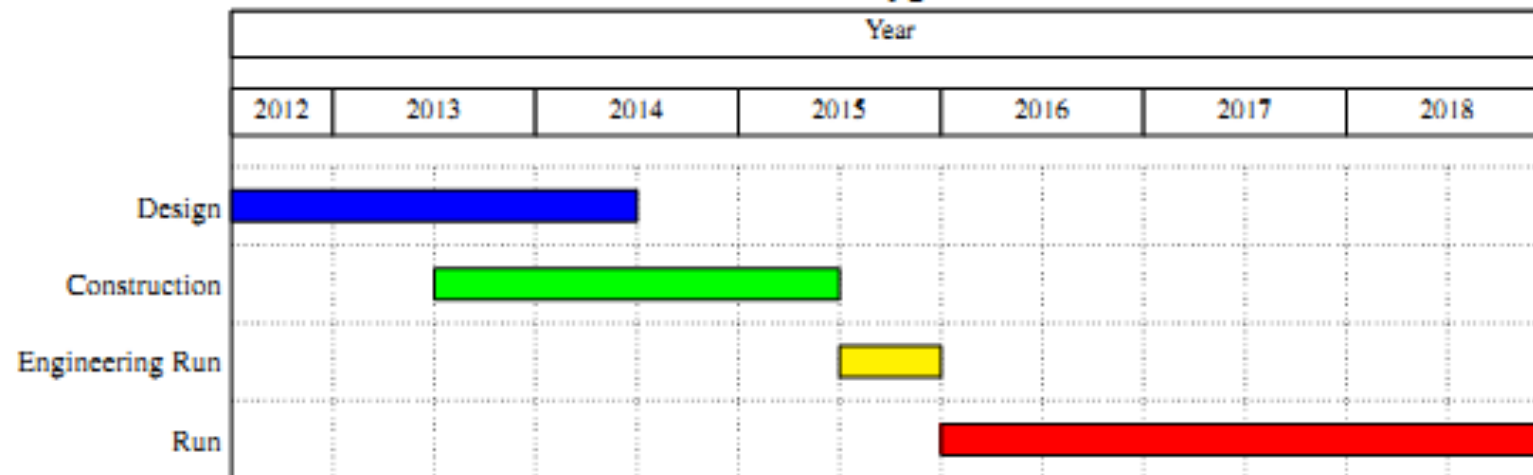
Plastic scintillator plate + SiPMs



Support structure

Time Line of Upgrade

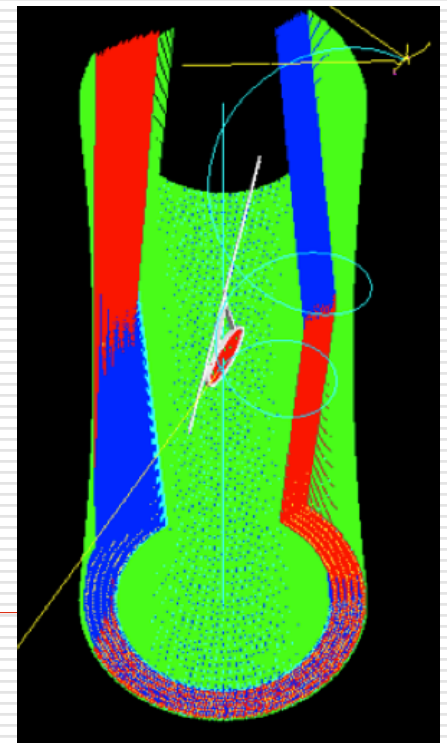
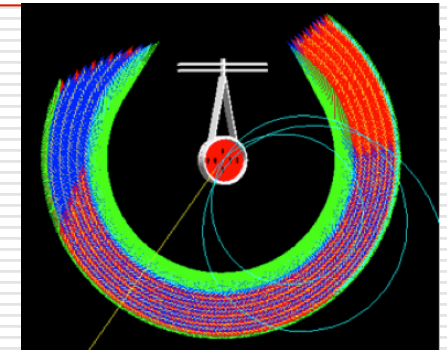
Gantt chart 1: Overall MEG Upgrade Schedule



New e^+ spectrometer: Drift Chamber

- We selected the following detector:
 - single volume gaseous detector
 - cylindrical shape with longitudinal wires
 - U-V stereo for hit positioning along the chamber axis
 - low mass gas ($\text{He} : i\text{C}_4\text{H}_{10} - 90:10$)
 - thin wires and small cell size

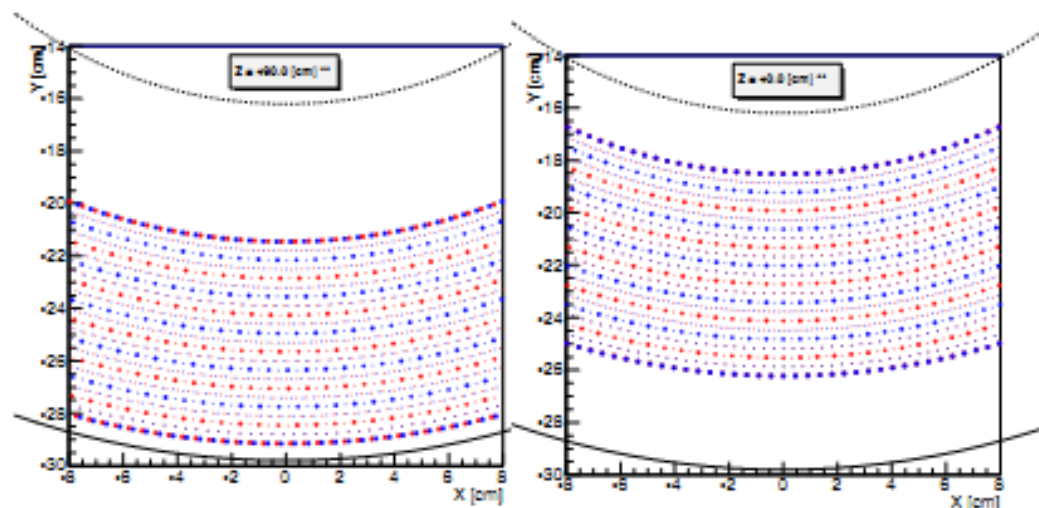
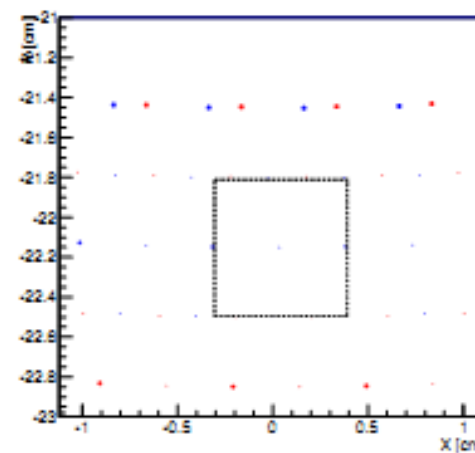
- Performances:
 - Single hit resolution ≤ 130 mm in r (proven exp.)
 - Momentum resolution $\sim 130\text{KeV}$ (MC simulation)
 - Angular resolution ~ 5 mrad (MC simulation)
 - DC-TC matching eff. $\sim 90\%$ (MC simulation)



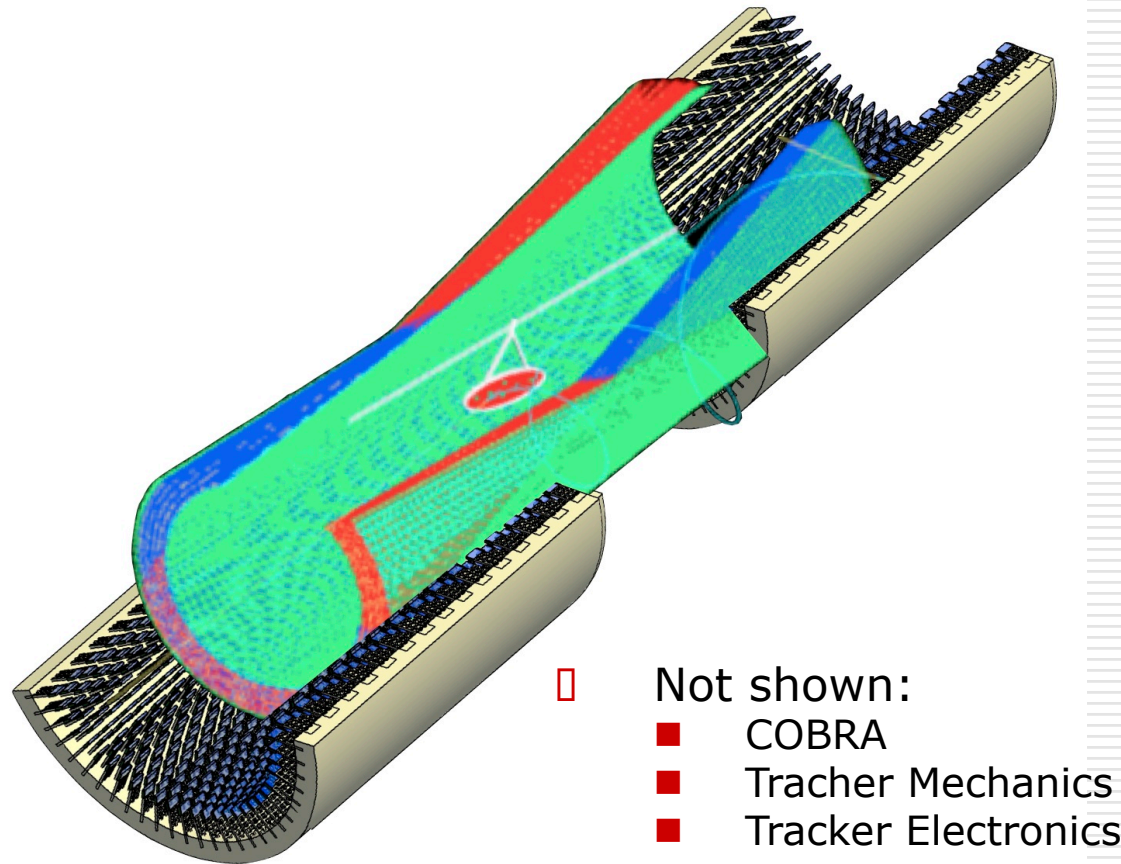
Geometry

Starting configuration

- 10 layers
- Square projective cells of 0.7 cm
- Stereo angle of ~ 8 deg with respect to Z
 - Z resolution ~ 7 time the transverse resolution
- 25 and 40 μm anode and field wires
- He / iC_4H_{10} mixture at 90/10 ratio
- Total length 180 cm
- Outer radius 29.2 cm
- ~ 1380 anode wires
- ~ 7500 field wires



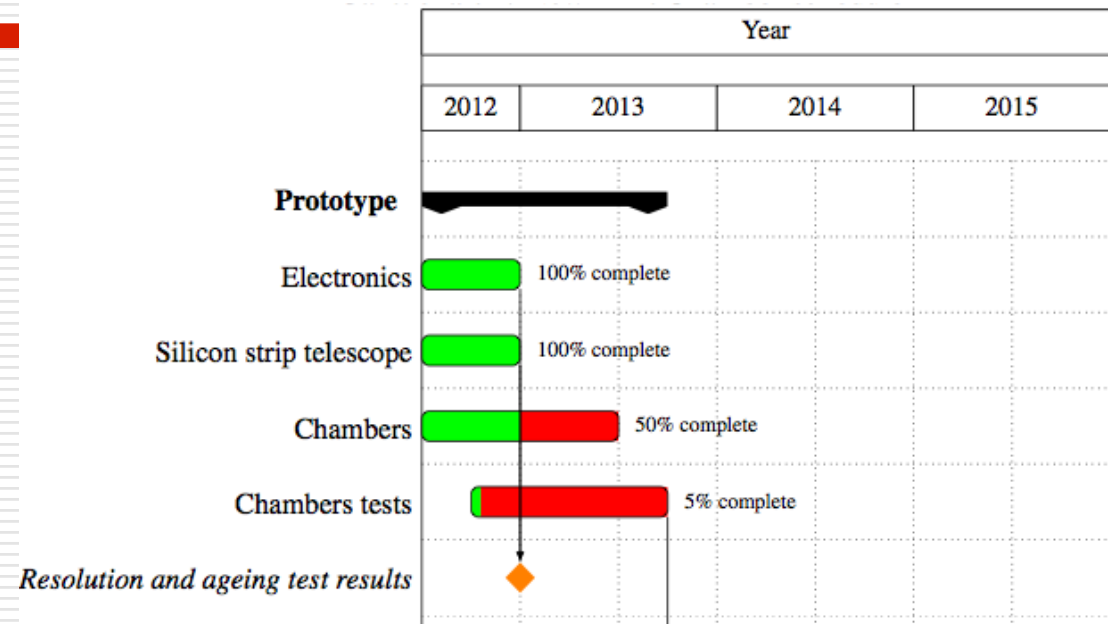
Pictorial view of positron spectrometer



Key elements

- Benefit from past experience and know how
 - similar chambers were already successfully operated for many years
 - new assembly technique has been defined and proved
- Use or reuse of existing infrastructures
- Work in parallel
 - PSI
 - INFN – Lecce
 - INFN – Rome
 - INFN - Pisa

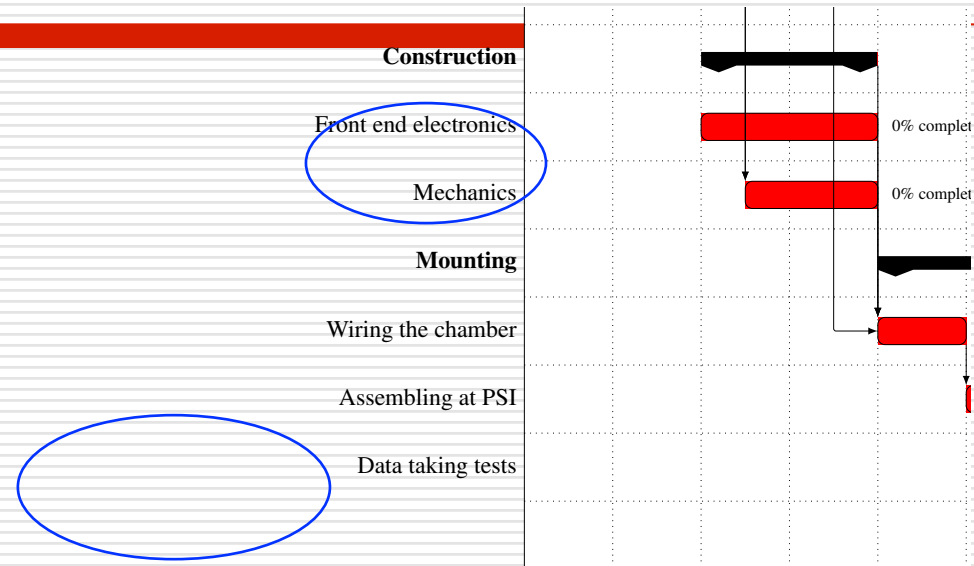
Schedule and milestones



Prototypes

- Short prototypes for hit resolution (Rm, Le, Pi)
- Si telescope for high precision tracking (Pi)
- Simple prototype for ageing (Pi)
- Long prototype to validate wire selection and mounting (Pi-Le)
- “complex” prototype for validation of construction procedure (Le)
- Mechanical prototype to compare End-Plates structure (le-Pi)

New year commitments

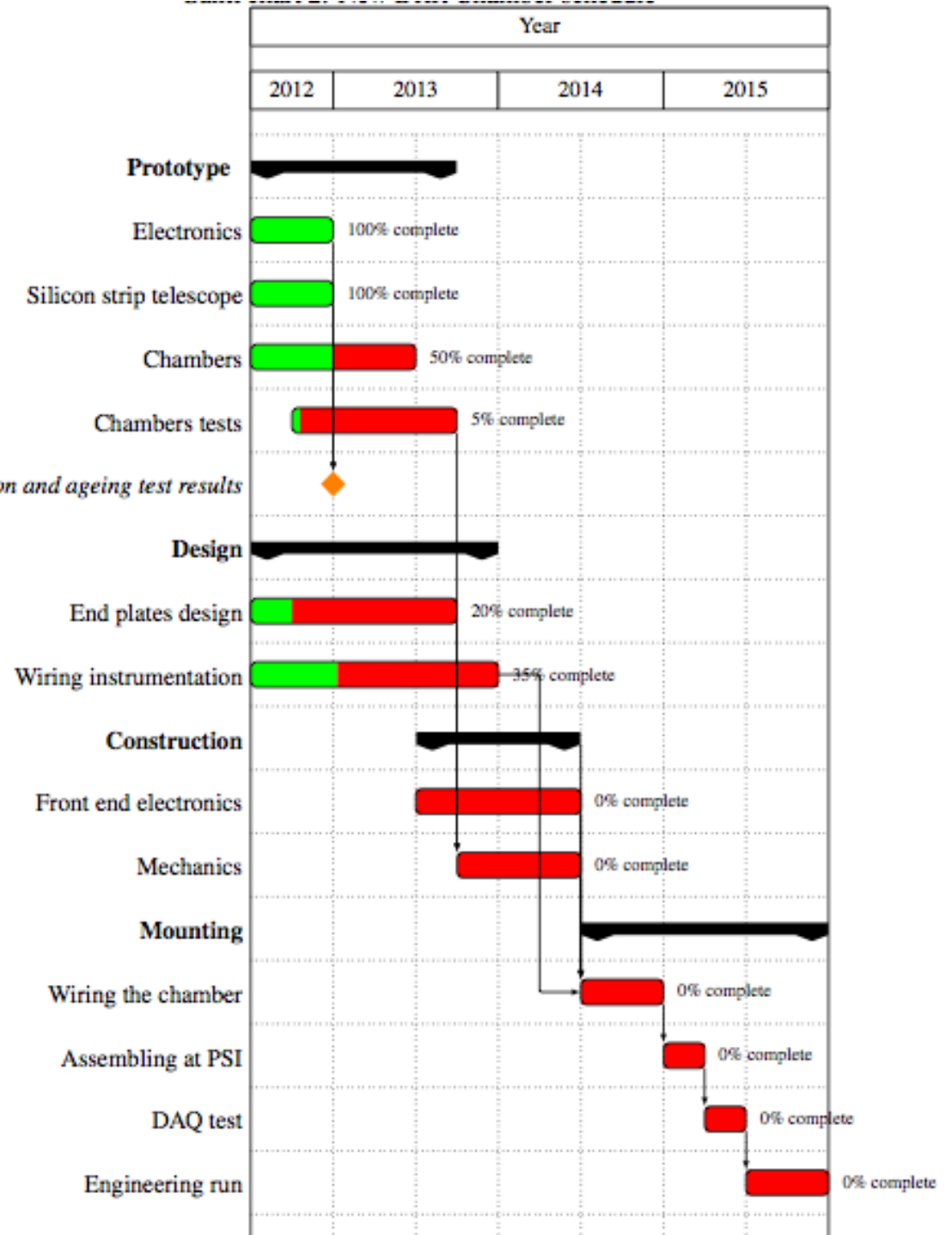


Full schedule

- Internal milestones
 - 10/2013 end of prototyping phase and end-plate design completion
 - 06/2014 ready for assembly
 - 04/2015 shipment to PSI
- Contingency
 - 06-09/2015 start of test run

6/27/13

Resolution and ageing test results



Tasks: prototypes

Several prototypes dedicated to answer specific questions

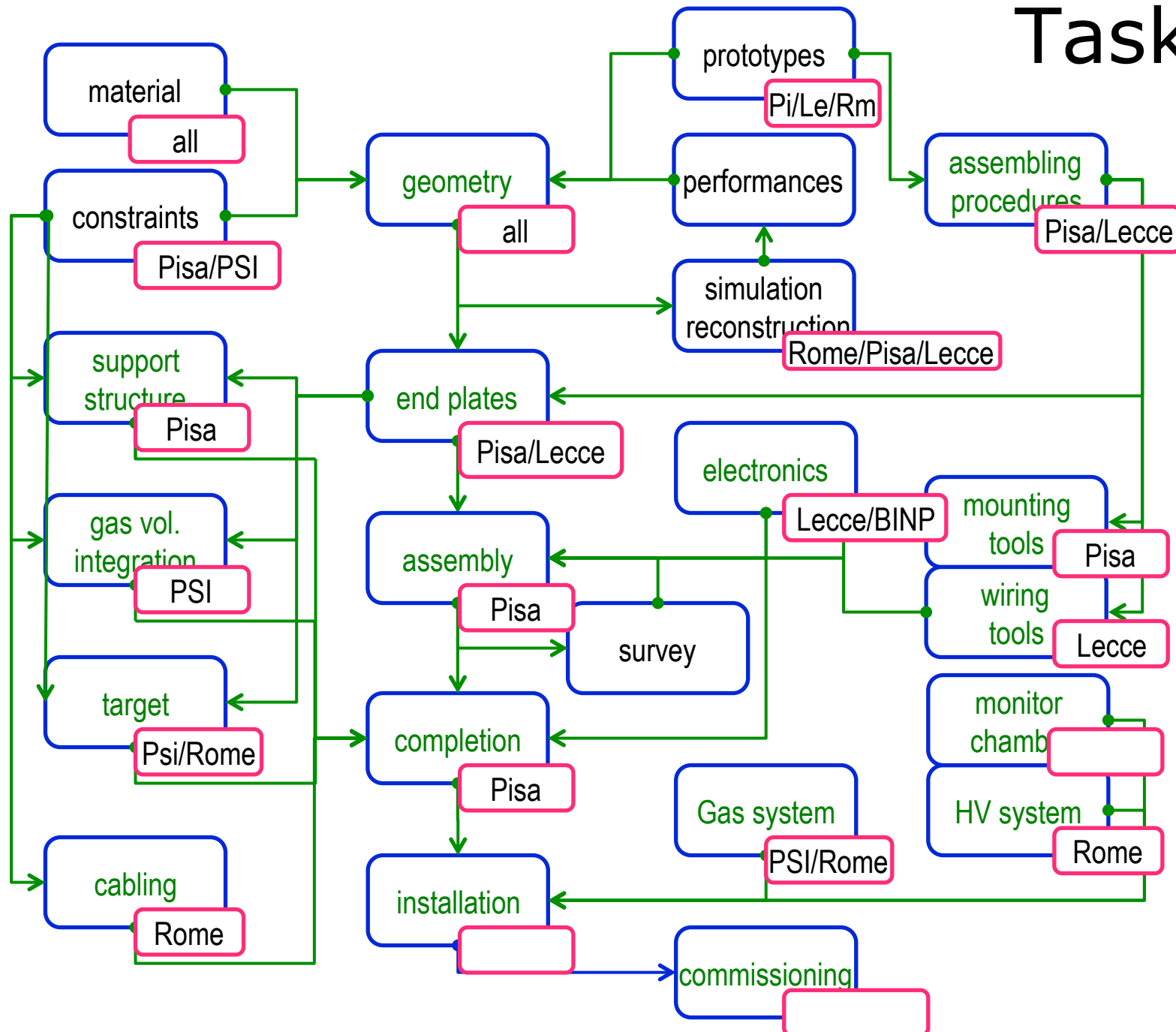
Existing prototypes

- Single hit resolution
 - Rome 8x8 chamber
 - Lecce tri-tube
 - Lecce large chamber (Mu2e)
- Ageing
 - Pisa prototype
- Mounting procedure
 - Lecce large chamber (Mu2e)
- FE electronics
 - Single, 6 channels, 10 channels differential

Other prototypes

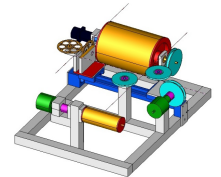
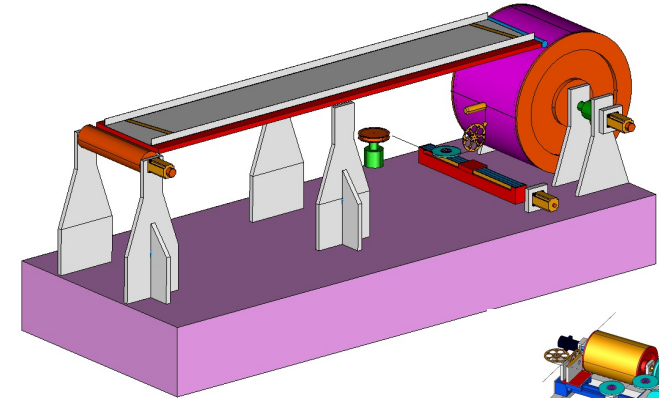
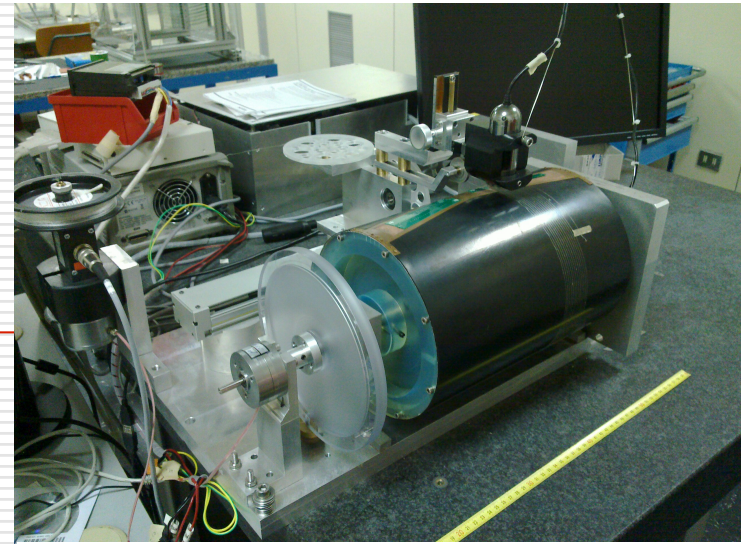
- Charge/Time division
- Wire type and cell stability
 - Full lenght simple prototype
- End-plate structure
 - MEchanical prototype
- FE electronic
- HV system
 - Custom vs. commercial vs. PSI solution
- Final mounting procedure
 - Single ended with cabling

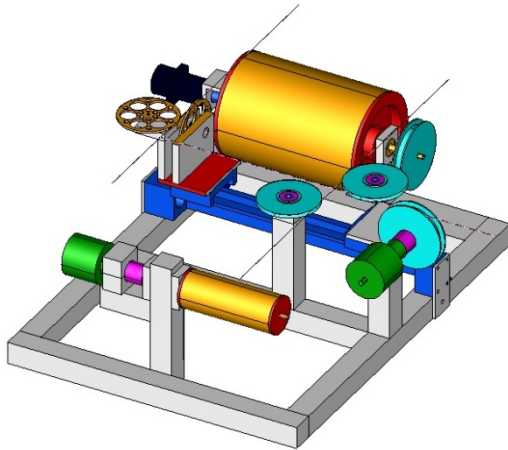
Tasks



Wiring robot parts procurements

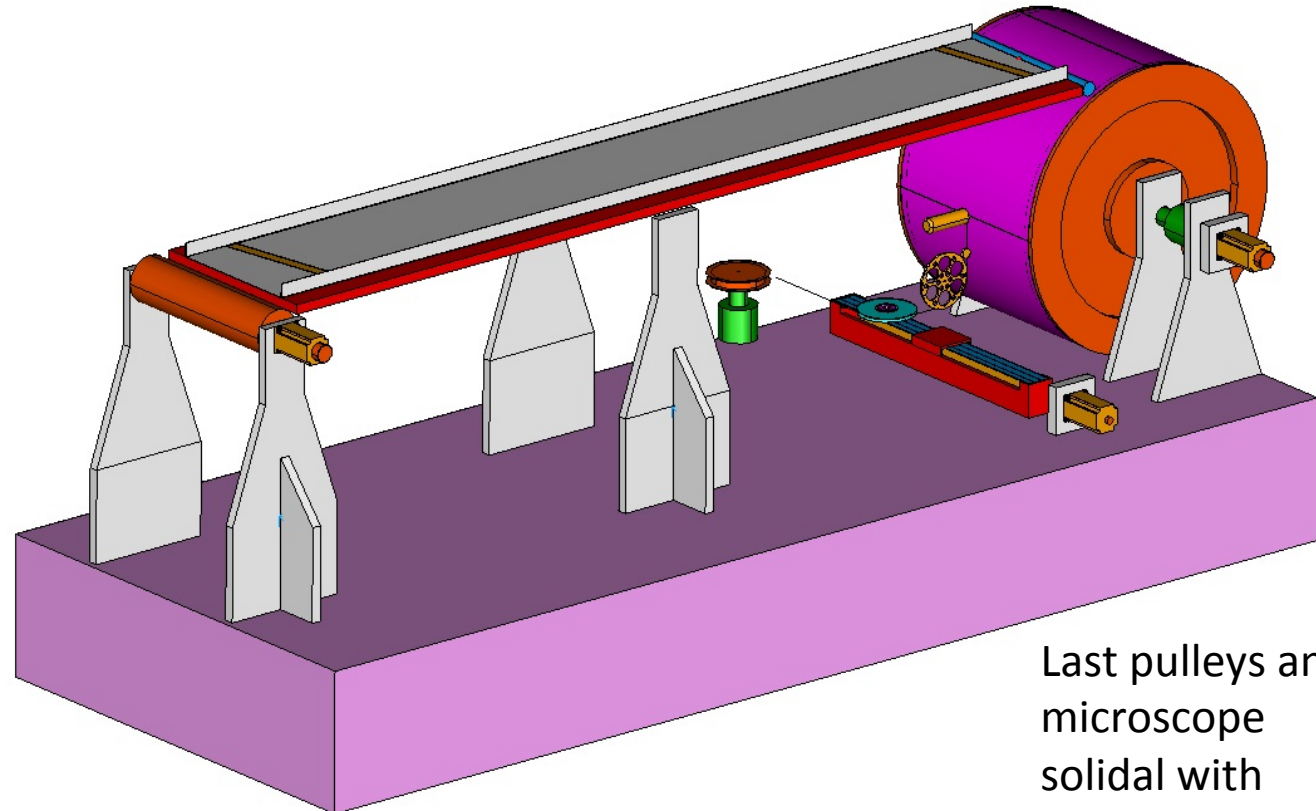
- ❑ Recycling parts from Mu2e prototype wiring robot: rotating axis, translation axis, torquemeter, e.m. friction, e.m. brake, digital microscope, monitoring system → **done**
- ❑ New parts: winding drum → **to be refurbished**
- ❑ Wire trays transport system → **design in progress**
- ❑ New mechanical supports → **to be designed and machined**



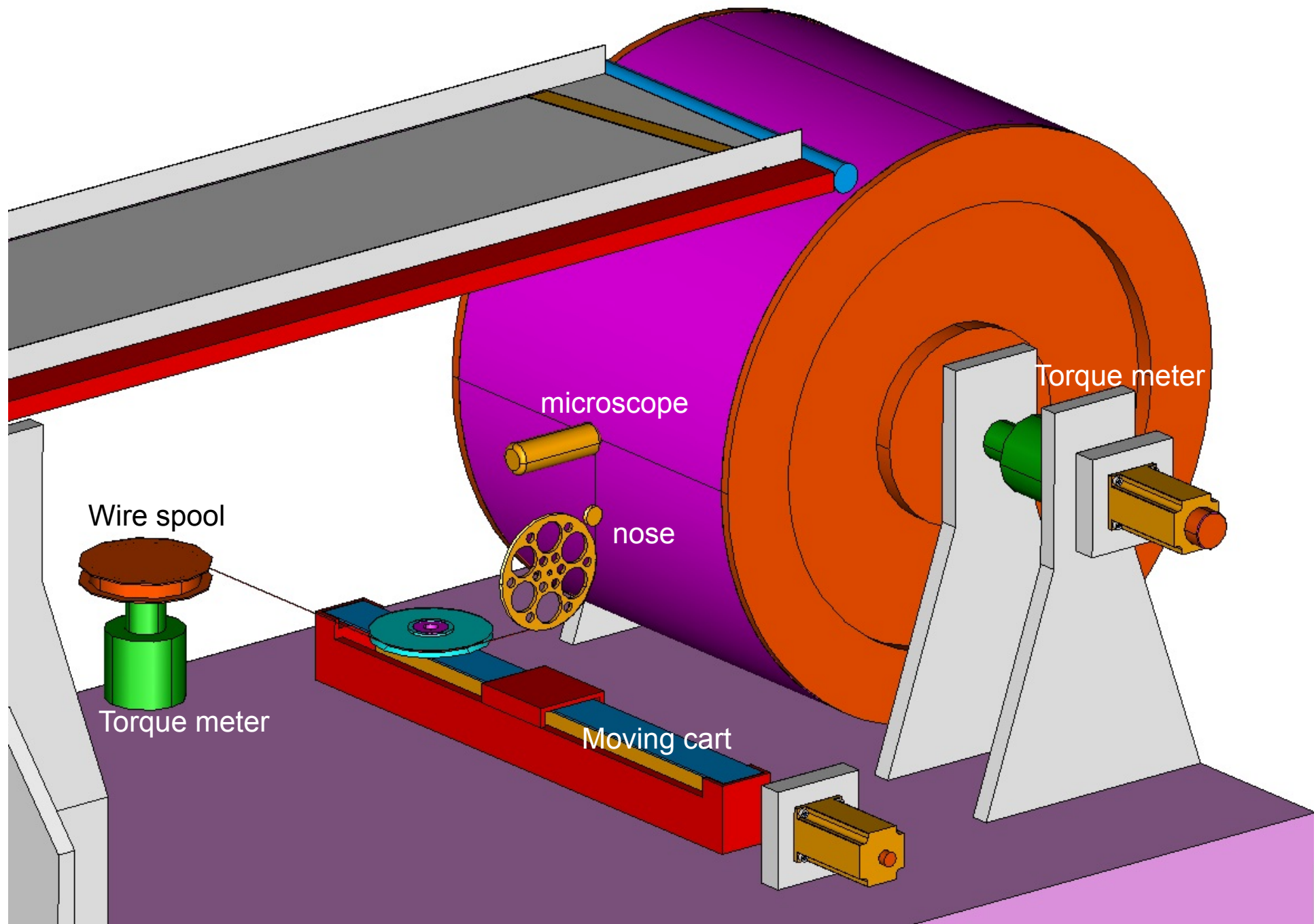


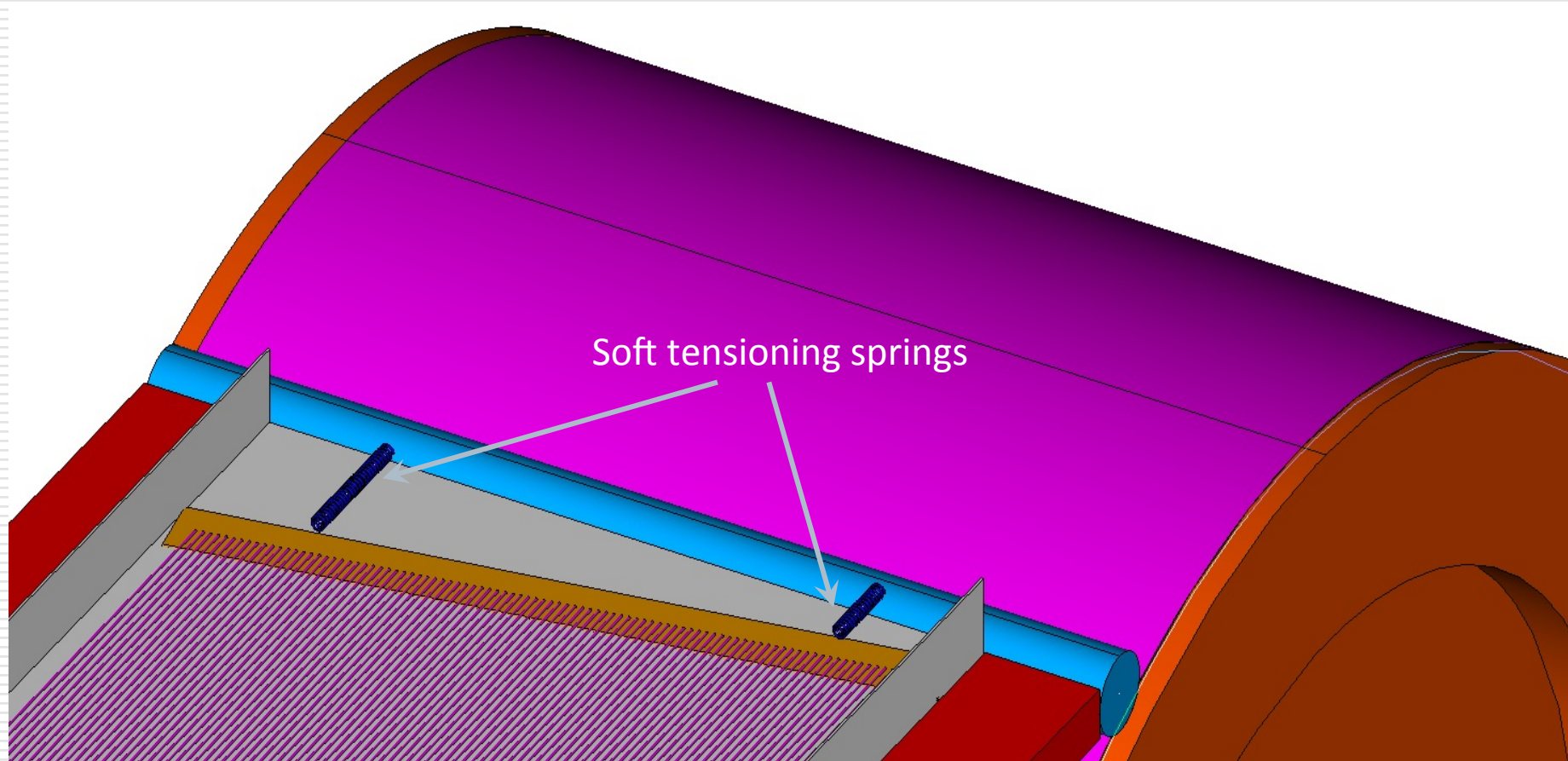
Old System

New system

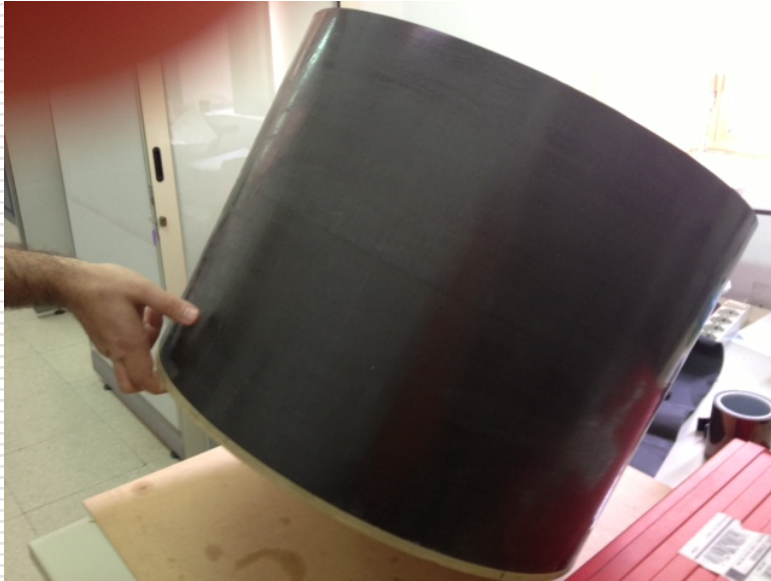


Last pulleys and
microscope
solidal with
translation axis





Carbon fiber cylinder



6/27/13

Wires

Order placed:

- 6000m Al-Ag plated
Ø 40µm (0.0016")
- 1500m Al-Ag plated
Ø 50µm (0.0020")
- 1500m W-Au plated
Ø 20µm (0.008")

Delivery: End of
September
(unfortunately partial
delivery not allowed)

6/27/13



http://www.le.infn.it
Sezione di Lecce
C.F. 84001850589 VAT IT04430461006

Purchasing order n. 635 del 24-MAG-13
(Please refer to this number in all future communications)

Your reference

Vendor Code INFN: 710717

Our reference CIG ZAC09FD438

Sezione di Lecce
Via Arnesano
73100 LECCE (LE)
Telefono : +39 0832.325127
Fax : +39 0832.325128

e-mail : prot@le.infn.it

CALIFORNIA FINE WIRE COMPANY
338 SOUTH FOURTH STREET P.O.BOX
446
- GROVER CITY CA 93433 STATI UNITI
D'AMERICA

We are hereby placing our formal order for the following items:

Short Description: FILI PER PROTOTIPO DI CAMERA A DRIFT DI MEG

QUANTITY	DESCRIPTION	DISCOUNT	%	UNIT PRICE	AMOUNT
6000	0.0016 ALUMINIUM 5056 SILVER PLATED 12 MICRO INCHES			2,66	15.960,00
1500	0.002 ALUMINIUM 5056 SILVER PLATED 12 MICRO INCHES			3,50	5.250,00
1500	0.0008 TUNGSTEN GOLD PLATED 3-5%			0,88	1.320,00
TOTAL USD :					22.530,00

PLACE OF DELIVERY Via Arnesano 73100 LE IT
DELIVERY TERMS 30 Giorni
METHOD OF SHIPMENT At your charge
PAYMENT CONDITIONS 60 DAYS I. D. Please, specify the bank details code in the invoice.
SUBCONTRACTS Subcontracting all or part of this contract is not permitted without formal authorization of INFN
JURISDICTION Any dispute relating to this contract is competent in the exclusive the Forum in Rome
APPLICABLE LAW The supply must be in accordance with existing legislation on safety at work

PROCEDURE MANAGER FIORE GIUSEPPE

E-Mail Address fiore@le.infn.it

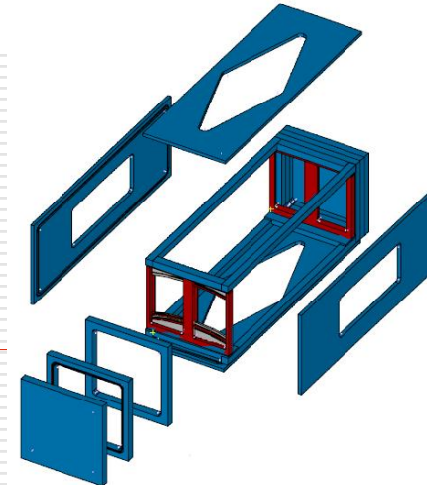
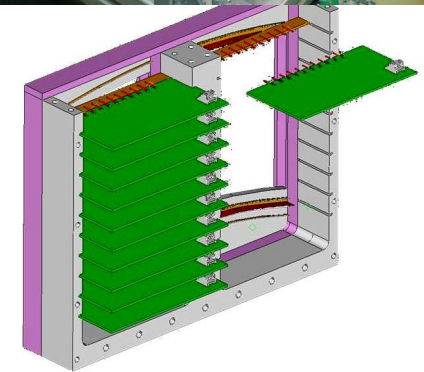
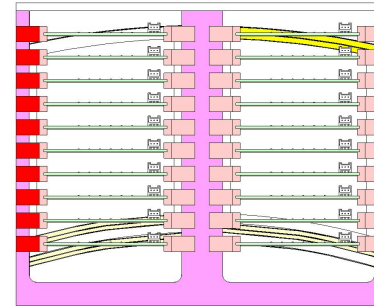
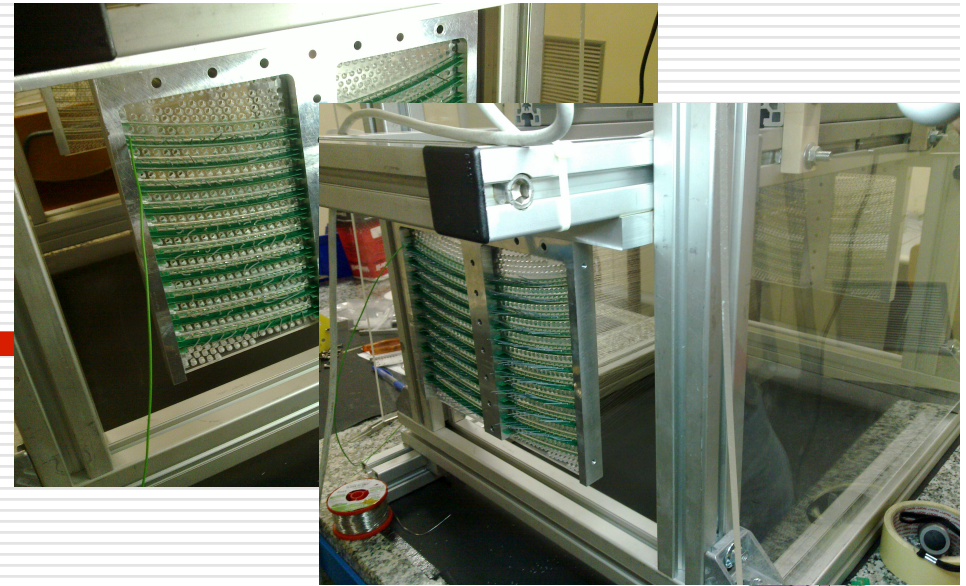
IL RESPONSABILE AMMINISTRATIVO
DAS. CARLA GENTILE

IL DIRETTORE
PROF. GIOVANNI MANCARELLA

GESTIONE CP	ESERCIZIO 2013	GRUPPO LE	ESPERIMENTO MEG	CAPITOLO U212_520910	IMPORTO 17.413,44
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Mu2e prototype

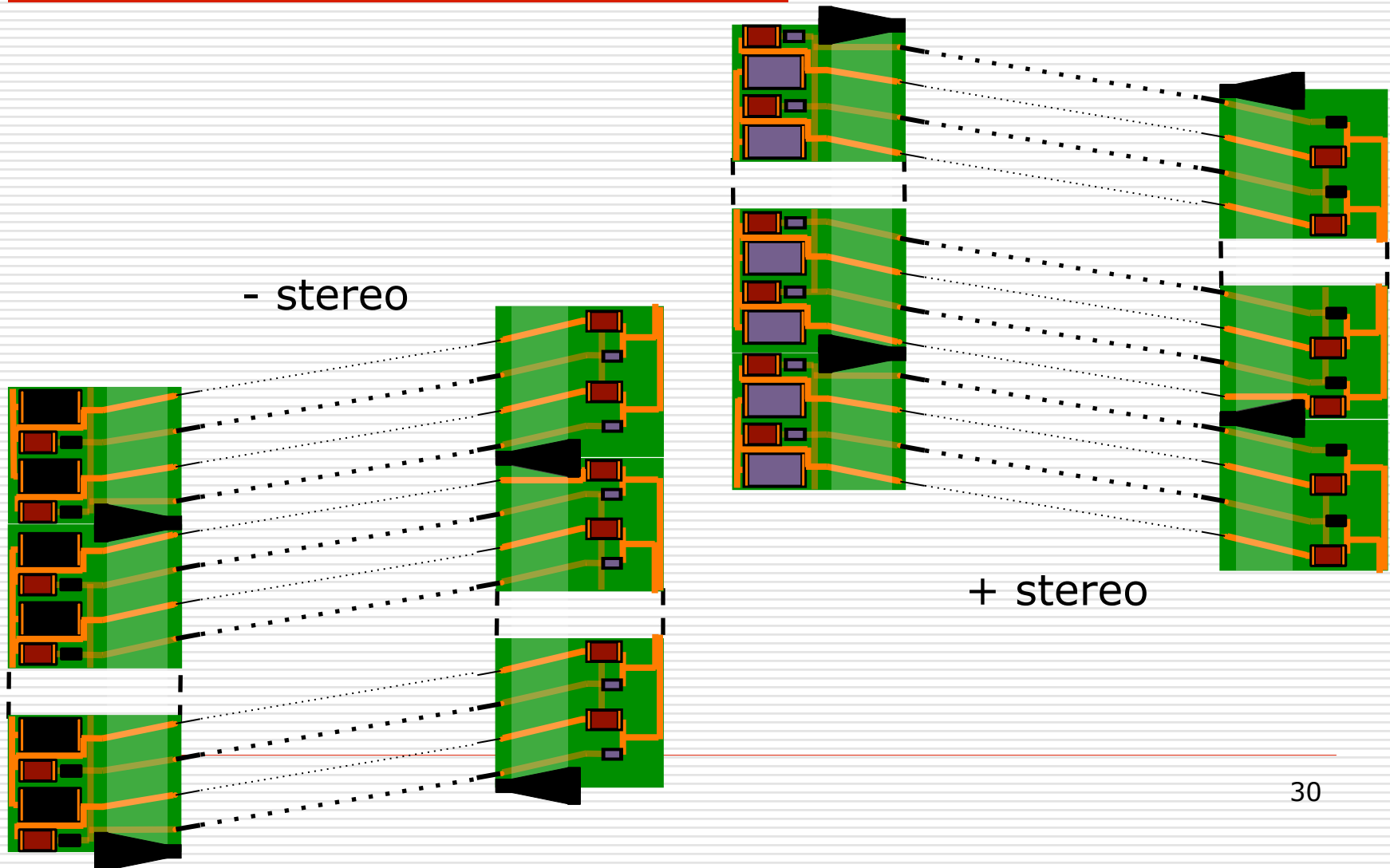
- Wiring: → **completed**
- Front-end and HV cards supports: → **completed**
- Gas envelope box: → **in progress**



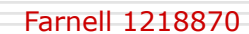
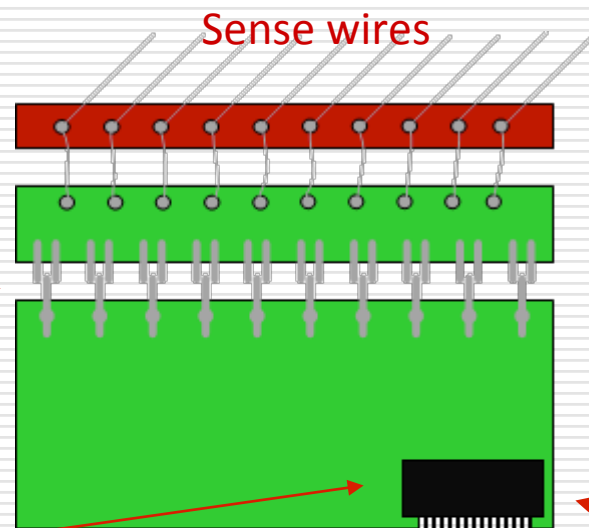
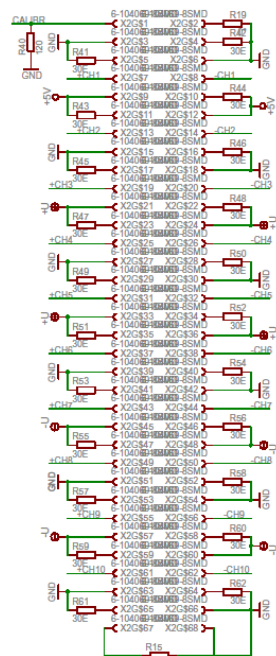
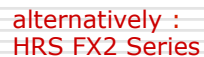
Wiring and connection complete
Waiting for interfacing PC-boards to front-end



Sense/Field wires boards



1.1 Introduction 1.2 Background 1.3 Objectives 1.4 Scope 1.5 Methodology 1.6 Results 1.7 Conclusion 1.8 References 1.9 Appendix 1.10 Index 1.11 Glossary 1.12 Abbreviations 1.13 Acronyms 1.14 Footnotes 1.15 Endnotes 1.16 References 1.17 Appendix 1.18 Index 1.19 Glossary 1.20 Abbreviations 1.21 Acronyms 1.22 Footnotes 1.23 Endnotes 1.24 References 1.25 Appendix 1.26 Index 1.27 Glossary 1.28 Abbreviations 1.29 Acronyms 1.30 Footnotes 1.31 Endnotes 1.32 References 1.33 Appendix 1.34 Index 1.35 Glossary 1.36 Abbreviations 1.37 Acronyms 1.38 Footnotes 1.39 Endnotes 1.40 References 1.41 Appendix 1.42 Index 1.43 Glossary 1.44 Abbreviations 1.45 Acronyms 1.46 Footnotes 1.47 Endnotes 1.48 References 1.49 Appendix 1.50 Index 1.51 Glossary 1.52 Abbreviations 1.53 Acronyms 1.54 Footnotes 1.55 Endnotes 1.56 References 1.57 Appendix 1.58 Index 1.59 Glossary 1.60 Abbreviations 1.61 Acronyms 1.62 Footnotes 1.63 Endnotes 1.64 References 1.65 Appendix 1.66 Index 1.67 Glossary 1.68 Abbreviations 1.69 Acronyms 1.70 Footnotes 1.71 Endnotes 1.72 References 1.73 Appendix 1.74 Index 1.75 Glossary 1.76 Abbreviations 1.77 Acronyms 1.78 Footnotes 1.79 Endnotes 1.80 References 1.81 Appendix 1.82 Index 1.83 Glossary 1.84 Abbreviations 1.85 Acronyms 1.86 Footnotes 1.87 Endnotes 1.88 References 1.89 Appendix 1.90 Index 1.91 Glossary 1.92 Abbreviations 1.93 Acronyms 1.94 Footnotes 1.95 Endnotes 1.96 References 1.97 Appendix 1.98 Index 1.99 Glossary 1.100 Abbreviations 1.101 Acronyms 1.102 Footnotes 1.103 Endnotes 1.104 References 1.105 Appendix 1.106 Index 1.107 Glossary 1.108 Abbreviations 1.109 Acronyms 1.110 Footnotes 1.111 Endnotes 1.112 References 1.113 Appendix 1.114 Index 1.115 Glossary 1.116 Abbreviations 1.117 Acronyms 1.118 Footnotes 1.119 Endnotes 1.120 References 1.121 Appendix 1.122 Index 1.123 Glossary 1.124 Abbreviations 1.125 Acronyms 1.126 Footnotes 1.127 Endnotes 1.128 References 1.129 Appendix 1.130 Index 1.131 Glossary 1.132 Abbreviations 1.133 Acronyms 1.134 Footnotes 1.135 Endnotes 1.136 References 1.137 Appendix 1.138 Index 1.139 Glossary 1.140 Abbreviations 1.141 Acronyms 1.142 Footnotes 1.143 Endnotes 1.144 References 1.145 Appendix 1.146 Index 1.147 Glossary 1.148 Abbreviations 1.149 Acronyms 1.150 Footnotes 1.151 Endnotes 1.152 References 1.153 Appendix 1.154 Index 1.155 Glossary 1.156 Abbreviations 1.157 Acronyms 1.158 Footnotes 1.159 Endnotes 1.160 References 1.161 Appendix 1.162 Index 1.163 Glossary 1.164 Abbreviations 1.165 Acronyms 1.166 Footnotes 1.167 Endnotes 1.168 References 1.169 Appendix 1.170 Index 1.171 Glossary 1.172 Abbreviations 1.173 Acronyms 1.174 Footnotes 1.175 Endnotes 1.176 References 1.177 Appendix 1.178 Index 1.179 Glossary 1.180 Abbreviations 1.181 Acronyms 1.182 Footnotes 1.183 Endnotes 1.184 References 1.185 Appendix 1.186 Index 1.187 Glossary 1.188 Abbreviations 1.189 Acronyms 1.190 Footnotes 1.191 Endnotes 1.192 References 1.193 Appendix 1.194 Index 1.195 Glossary 1.196 Abbreviations 1.197 Acronyms 1.198 Footnotes 1.199 Endnotes 1.200 References</
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Twisted flat
cable
68 contacts
(signals/power)



power

Signals/gnd

Wire signals/ power distribution

FE Side #1

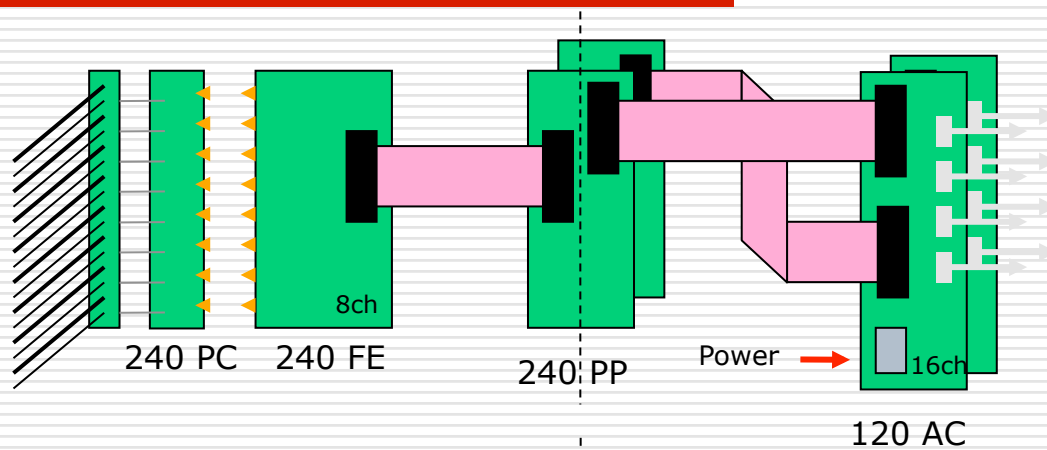
HDMI standard

Pros: high speed (3.4GS/s), cheap

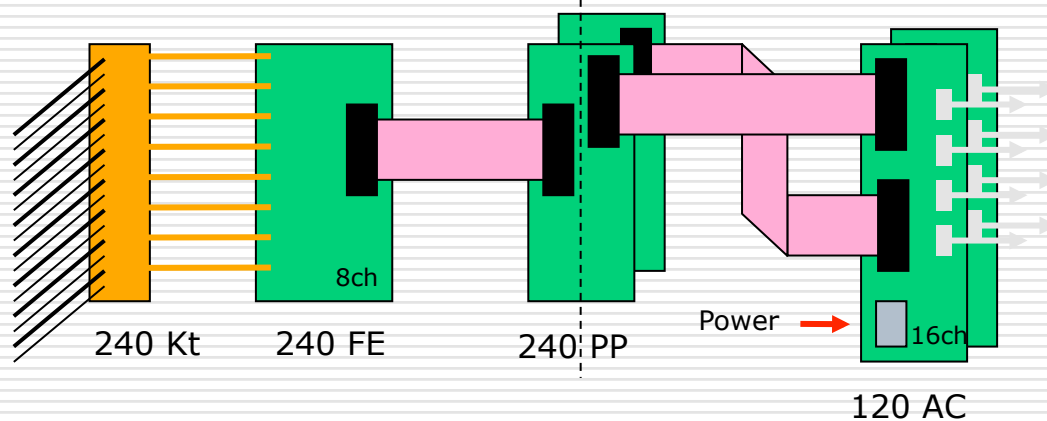
Cons: Low multiplicity (4ch/cable)



FE Side #1a



FE Side #1b



Power supply

$$\text{Ch} := 1920$$

$$P := 200 \text{ mW}$$

$$V_{\text{ch}} := 3 \text{ V}$$

$$I := \frac{P}{V_{\text{ch}}}$$

$$I = 66.667 \text{ mA}$$

$$\text{Slot} := 20$$

$$\text{Ch_dig} := 16$$

$$\text{Slot} \cdot \text{Ch_dig} = 320$$

$$\frac{\text{Ch}}{(\text{Slot} \cdot \text{Ch_dig})} = 6$$

$$\text{Slot} \cdot \text{Ch_dig} \cdot P = 64 \text{ W}$$

$$f_c := 1.2$$

$$I \cdot (\text{Slot} \cdot \text{Ch_dig}) \cdot f_c = 25.6 \text{ A}$$

$$25 \cdot 3 \cdot 2 = 150$$

$$N_c := 2$$

$$I \cdot (\text{Slot} \cdot \text{Ch_dig}) \cdot f_c \cdot V_{\text{ch}} \cdot N_c = 153.6 \text{ W}$$

canali

Potenza per alimentazione del canale

tensione di alimentazione

corrente assorbita per canale

slot AC (una usata per servizio)

canali per AC

canali per crate

numero crate

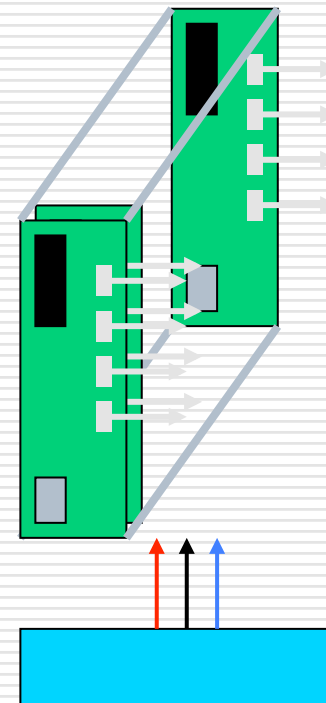
potenza per alimentazione del crate

fattore di sicurezza

corrente per alimentazione del crate

alimentatori per crate

potenza per crate

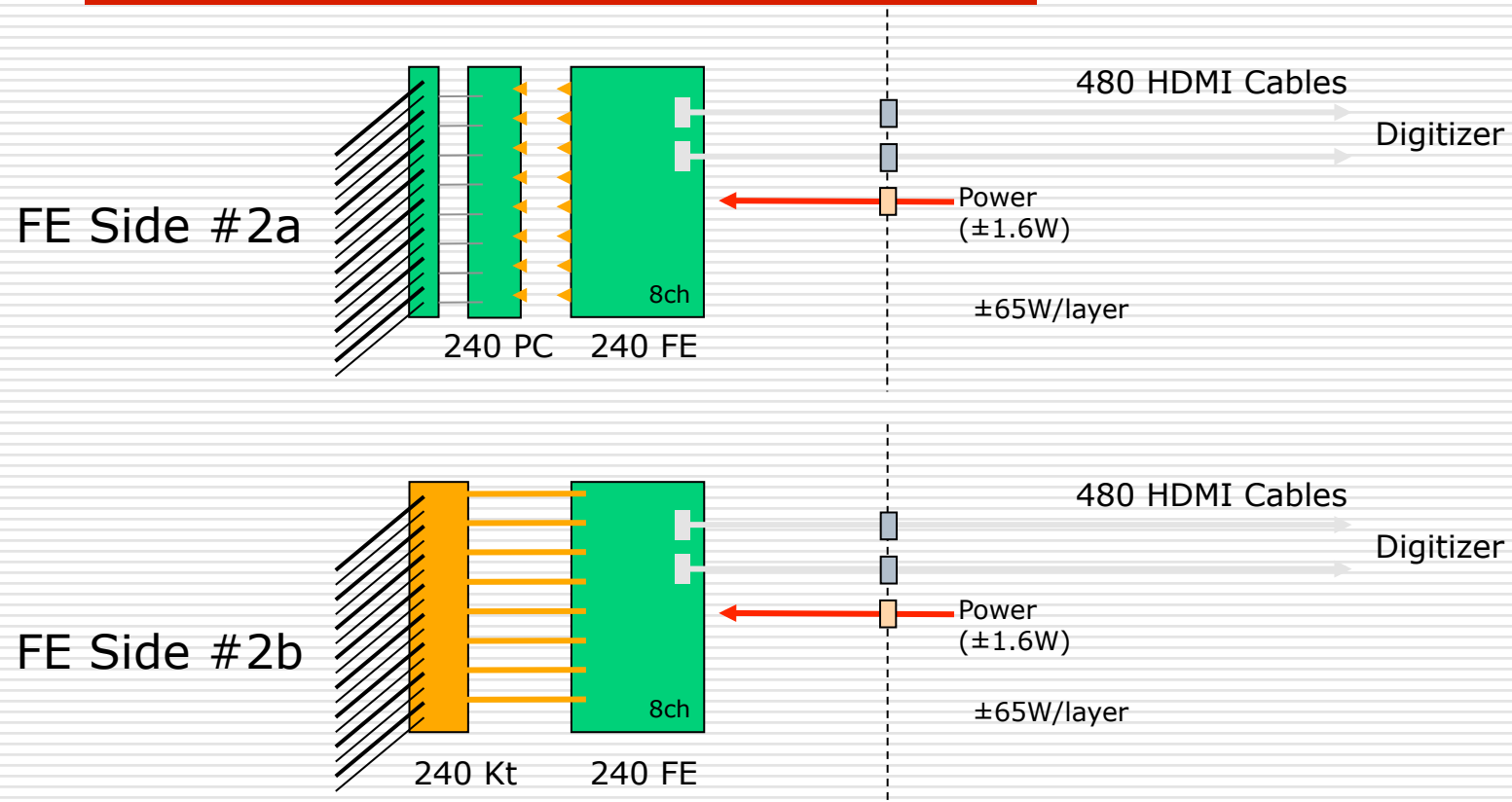


20+1 slots crate
320 Ch's

±3V / 25A
Power Supply

6 crate
150W/crate

FE Side #2



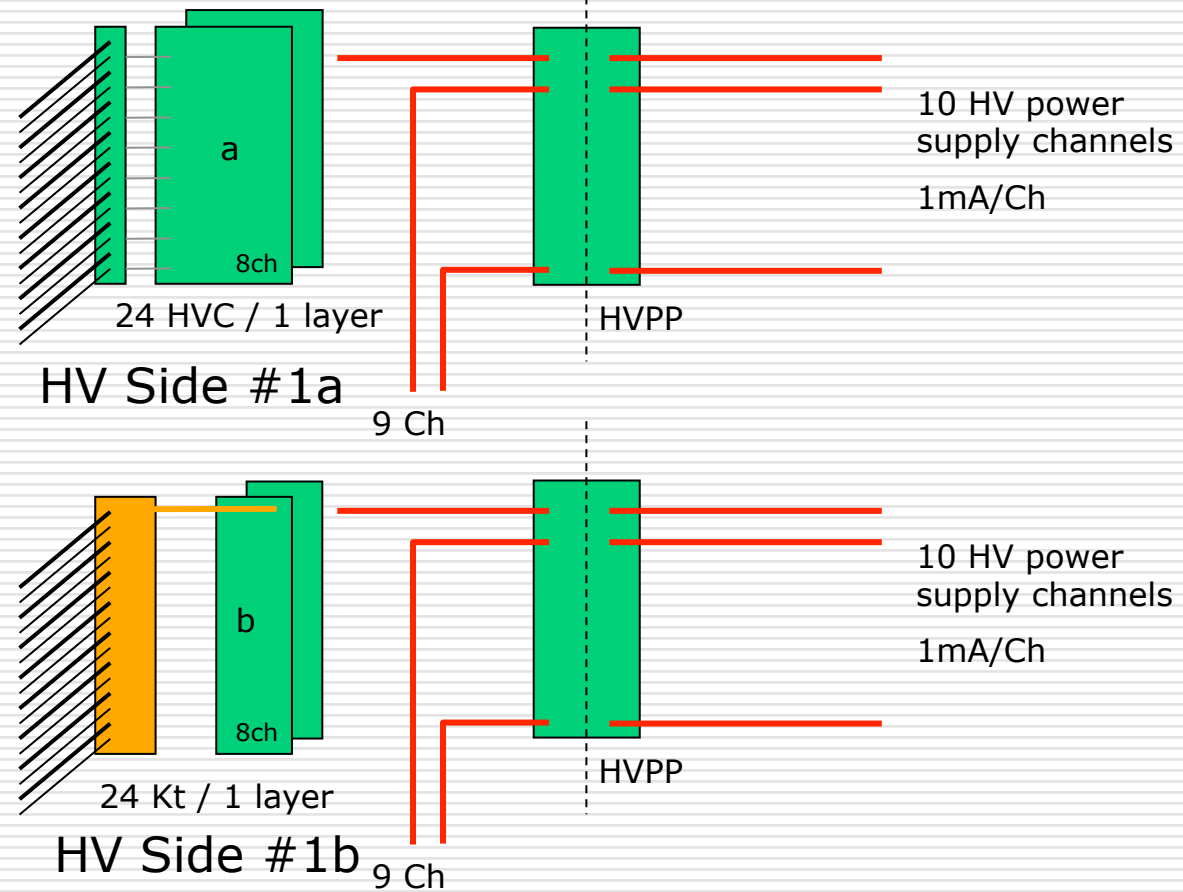
HV Side



TE 1218055-1
LGH Micro-Miniature Connectors and
Cable Assemblies



TE 1218147-1
LGH Micro-Miniature Connectors and
Cable Assemblies



Card connector

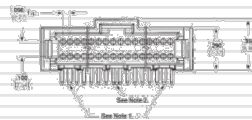
Male on PCB



3M 81068-520203

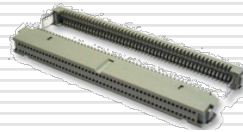


3M 81068-600203
RB

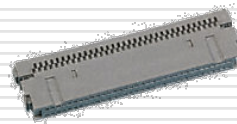


 6-104069-8

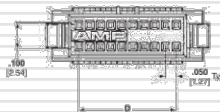
Female on PCB



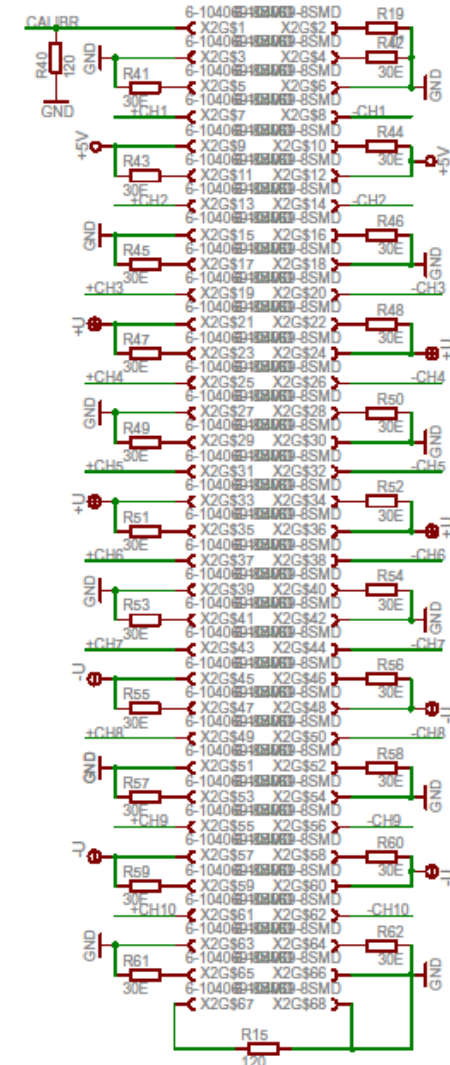
3M 82068-6000RB



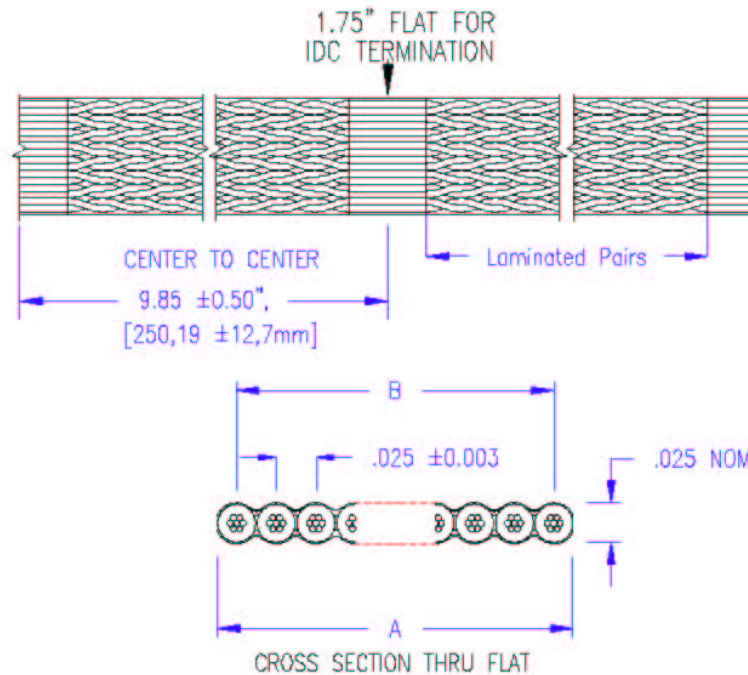
3M 82068-6000RB



 **TE** 3-111196-4
connectivity



Flat cable



CROSS SECTION THRU FLAT

Part Number	Count	Pairs	A Span	B Span
125-3097-998	68	34	1.701 NOM	1.675 ±0.010

PHYSICAL

Conductors: 30 AWG 7/38 Tinned Copper
 Insulation: .006" TPO
 Color Code: 1st Pair Red/White followed by Orange/White and Repeat
 Laminate: Polyester
 Temperature Rating: 80°C

ELECTRICAL

Impedance: 90 ±6 ohms ¹ 122 ±5 ohms ²
 Capacitance: 17 pF/ft @ 1 MHz ¹ 11 pF/ft @ 1 MHz ²
 Propagation Delay: 1.45 ns/ft
 Voltage Rating: 150 V
 Current Rating: 0.75 A
 DC Resistance: 106 ohm per 1,000 ft @ 20°C

¹ Above values measured Single-Ended.

² Above values measured Differentially.

Approvals: UL AWM Style 20744
 CSA AWM

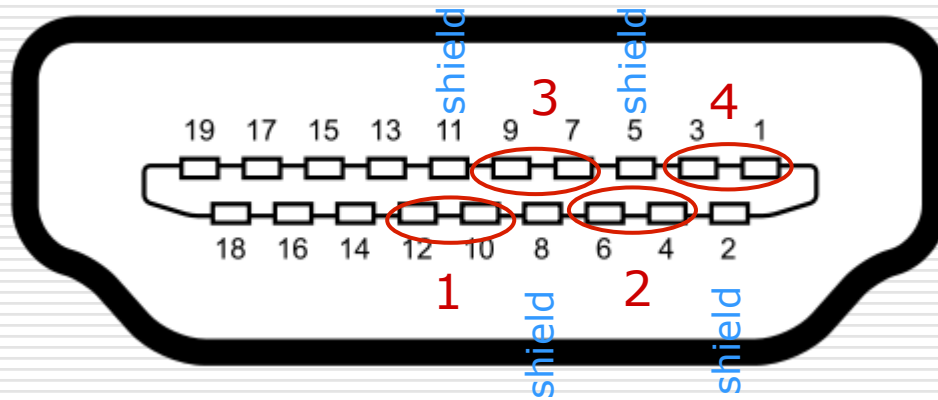
Print Legend: **Amphenol SPECTRA-STRIP**

UL® AWM 80C LL31941 CSA AWM I A80C 150V FT-1
 30 AWG Stranded ULTRA 320 SCSI™ Compliant

All Dimensions in Inches, Unless Otherwise Noted

DRAWN	PROD ENG	QA	MKT	P/ECN#	DRAWING NO. 125-3097-998	AMPHENOL SPECTRA-STRIP 720 SHERMAN AVE TEL (203) 281-3200 HAMDEN CT 06514 FAX (203) 281-5872	Rev F
FITS 8/15/01					TITLE: .025" Twist 'N' Flat®		SHEET 1 of 1
					Full Lamination, 30 AWG 7/38		

HDMI Connector (Type A)

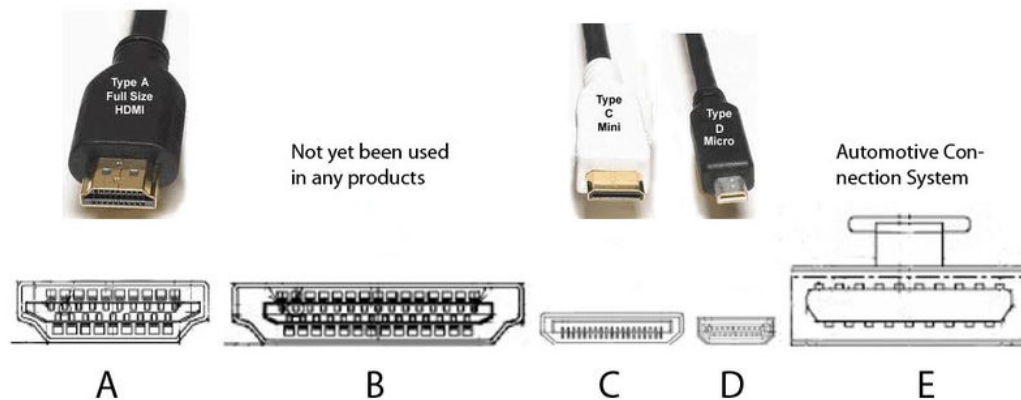


Pros:

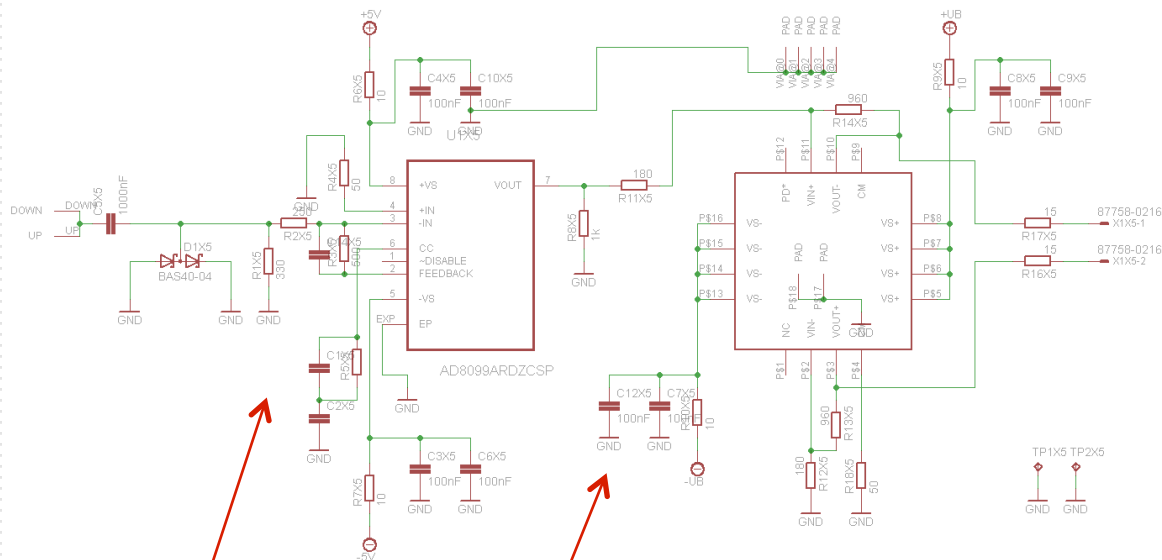
- High speed (3.4GS/s)
- Very Cheap : 1.8m w connectors 8.23€(Farnell)

Con:

- Low multiplicity (4ch/cable)



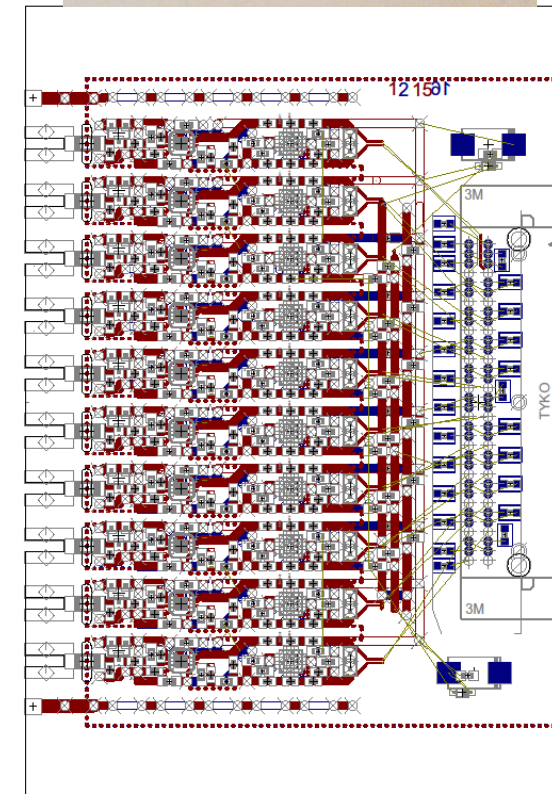
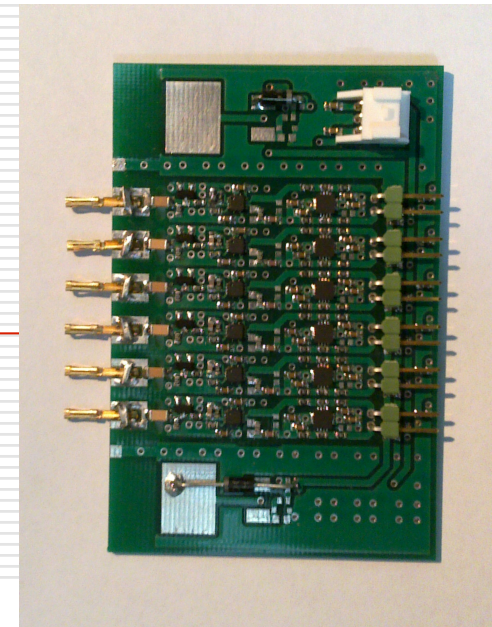
Lecce FE



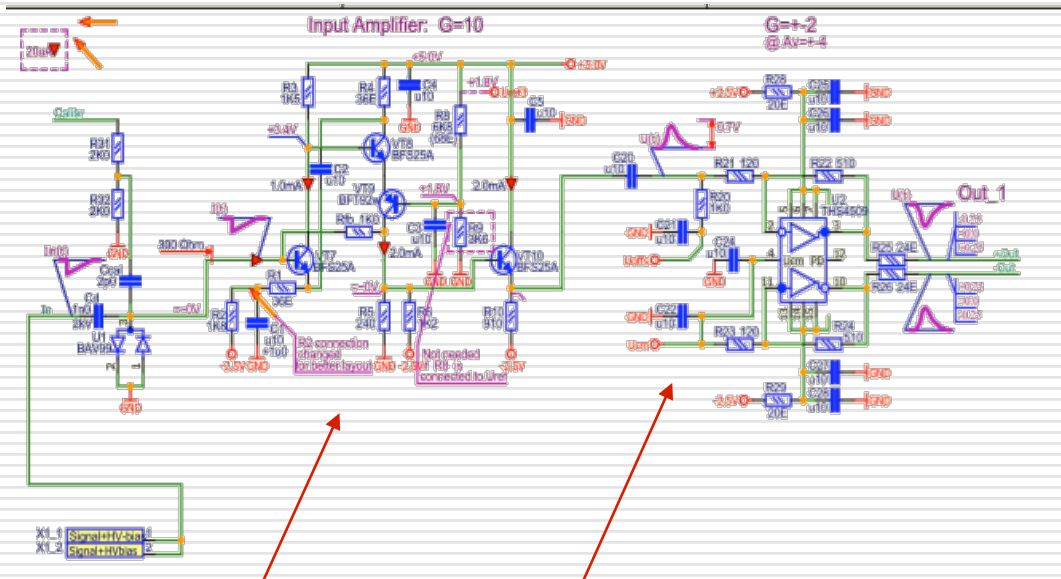
AD8099 Low Noise and Low Distortion High Speed Op-Amp → pre amplifier

THS4509 Wideband Full-Differential Op-Amp → second stage gain output driver

- Input voltage dynamical range $0 \div 150\text{mV}$
- Differential output
- Integral non-linearity $< 1.5\%$
- Output voltage noise (120Ω load) $< 2\text{mV}$
- -3dB bandwidth $\sim 800\text{MHz}$
- Power consumption 150mW/ch (50mA @ $\pm 3\text{V}$)



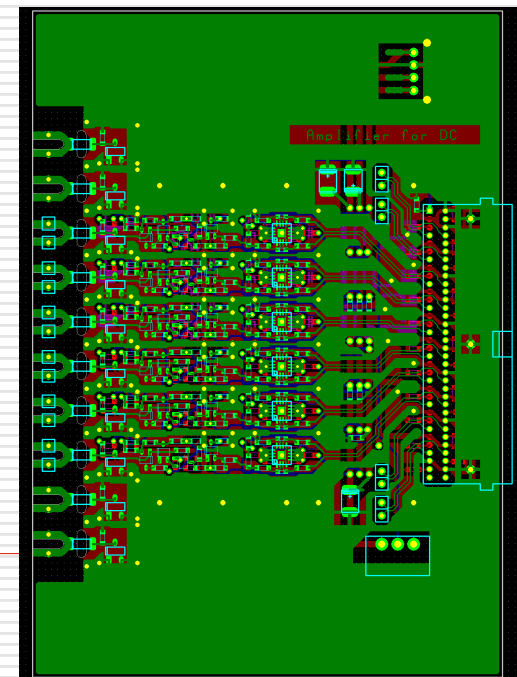
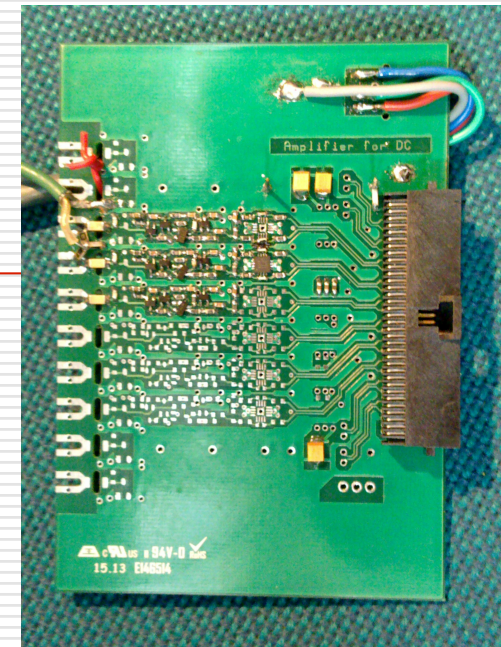
BIMP FE



Discrete components (4BJTs)

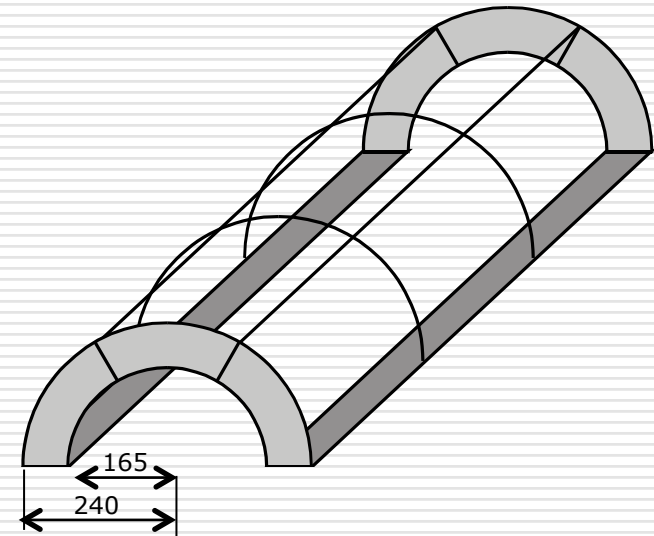
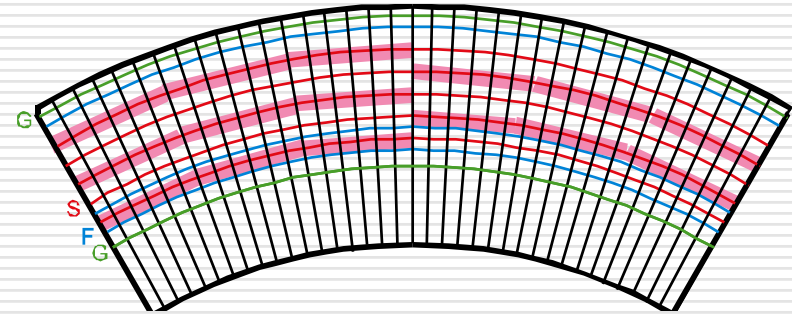
→ pre amplifier

THS4509 Wideband Full-Differential Op-Amp → second stage gain output driver



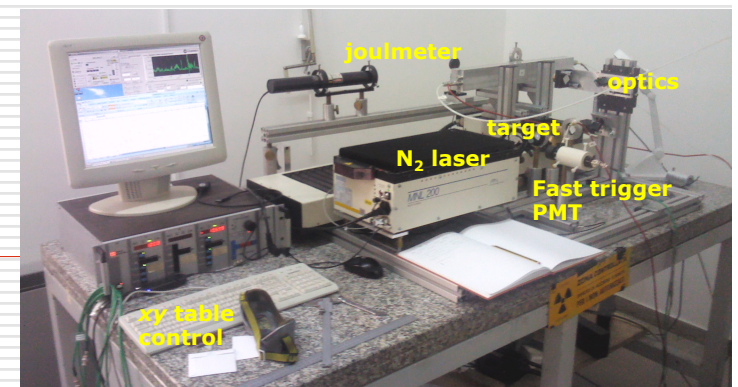
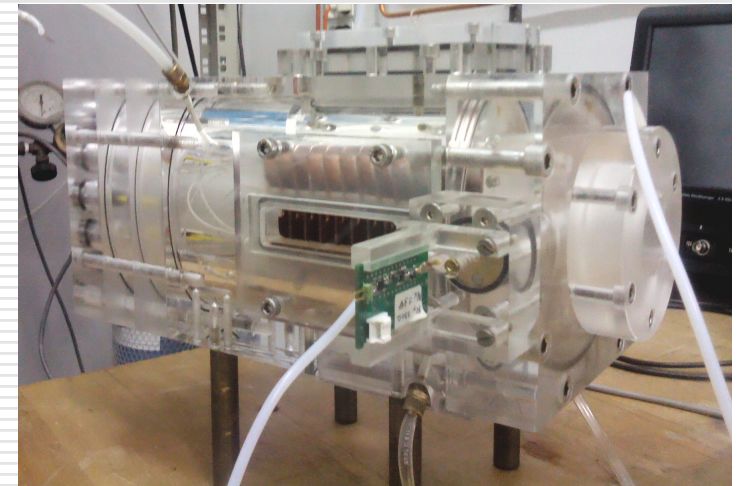
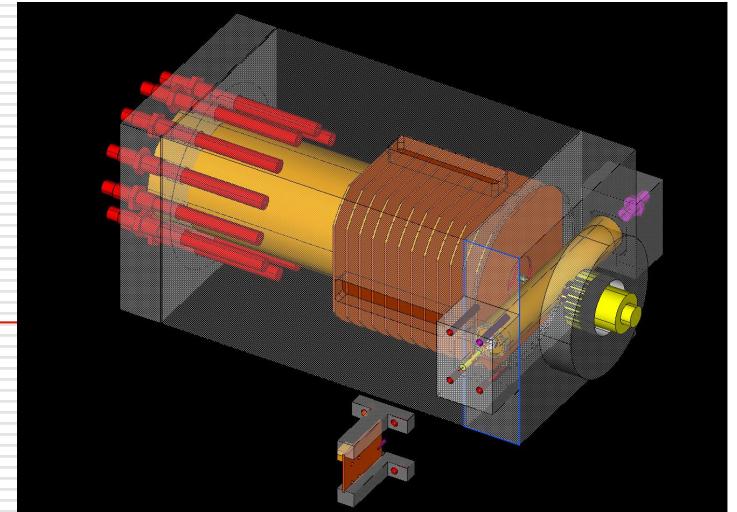
Full length prototype

- System design: → **in progress**
- Wire board anchoring system: → **conceptual design done**
- Wire boards: → **to be designed**
- Spacers: → **to be designed**



Drift velocity, diffusion and ionization yield measurements

- Uniform E field ($>1.2\text{kV/cm}$) between plates
- N_2 laser generate a single electron between plates
- Arrival times give precise determination of v_{drift}
- Variance gives longitudinal diffusion
- After that: Lateral diffusion, primary ionization
- Gas leakage tests and HV test are in progress
- **Full working**



Lecce people

Michele Cascella	AssRic	70
Cavallo Emanuela	AssRic	100
Grancagnolo Francesco	Ric	70
Maffezzoli Alfonso	PO	20
Panareo Marco	PA	100
Pepino Aurora	Dott	100
Tassielli Gianfranco	Ric	50
Zavarise Giorgio	PO	20
TOT		530
Primiceri Patrizio	CTech	100
TOT		100

Descrizione	Costo	FE Opt. #1a	FE Opt. #1b	FE Opt. #2a	FE Opt. #2b				
HDMI Passante	€ 10,00	0	0	480	480	€ 0,00	€ 0,00	€ 4.800,00	€ 4.800,00
Cavo HDMI Int	€ 2,00	0	0	480	480	€ 0,00	€ 0,00	€ 960,00	€ 960,00
Cavo HDMI Ext	€ 3,00	480	480	480	480	€ 1.440,00	€ 1.440,00	€ 1.440,00	€ 1.440,00
FE pcb	€ 5,40	240	240	240	240	€ 1.296,00	€ 1.296,00	€ 1.296,00	€ 1.296,00
FE mont/test	€ 340,00	240	240	240	240	€ 81.600,00	€ 81.600,00	€ 81.600,00	€ 81.600,00
PC pcb	€ 3,30	240	0	240	0	€ 792,00	€ 0,00	€ 792,00	€ 0,00
PC mont	€ 120,00	240	0	240	0	€ 28.800,00	€ 0,00	€ 28.800,00	€ 0,00
Wires pcb	€ 2,80	240	0	240	0	€ 672,00	€ 0,00	€ 672,00	€ 0,00
Kt pcb	€ 5,50	0	240	0	240	€ 0,00	€ 1.320,00	€ 0,00	€ 1.320,00
Kt mont	€ 120,00	0	240	0	240	€ 0,00	€ 28.800,00	€ 0,00	€ 28.800,00
PP pcb	€ 4,50	240	240	0	0	€ 1.080,00	€ 1.080,00	€ 0,00	€ 0,00
PP mont/test	€ 80,00	240	240	0	0	€ 19.200,00	€ 19.200,00	€ 0,00	€ 0,00
AC pcb	€ 12,00	120	120	0	0	€ 1.440,00	€ 1.440,00	€ 0,00	€ 0,00
AC (active) mont/test	€ 235,00	120	120	0	0	€ 28.200,00	€ 28.200,00	€ 0,00	€ 0,00
Crate AC	€ 208,00	6	6	0	0	€ 1.248,00	€ 1.248,00	€ 0,00	€ 0,00
Flatcable Int	€ 50,00	240	240	0	0	€ 12.000,00	€ 12.000,00	€ 0,00	€ 0,00
Flatcable ext	€ 100,00	240	240	0	0	€ 24.000,00	€ 24.000,00	€ 0,00	€ 0,00

totali € 201.768,00 € 201.624,00 € 120.360,00 € 120.216,00

missing booster amplifier

Wires HV pcb	€ 2,80	240	0		€ 672,00	€ 0,00
Wires HV Kt pcb	€ 5,50	0	240		€ 0,00	€ 1.320,00
Kt mont	€ 120,00	0	240		€ 0,00	€ 28.800,00
HVC a pcb	€ 3,40	240	0		€ 816,00	€ 0,00
HVC a mont	€ 135,00	240	0		€ 32.400,00	€ 0,00
HVC b pcb	€ 3,30	0	240		€ 0,00	€ 792,00
HVC b mont	€ 100,00	0	240		€ 0,00	€ 24.000,00
HV_panel_connector	€ 48,40	10	10		€ 484,00	€ 484,00
HV cable Int	€ 80,00	10	10		€ 800,00	€ 800,00

totali € 35.172,00 € 56.196,00

LV Power supply	€ 3.388,00	8			€ 27.104,00	
Cable 10mm ²	€ 45,30	4			€ 181,20	
Sense cable 2.5mm ²	€ 164,00	1			€ 164,00	
Connettori	€ 25,00	1			€ 25,00	

totali € 27.474,20

Richieste

□ Chamber wiring and construction

- Positioning and alignment monitoring: **5k€**
- Material (wires, supports): **90k€**

□ Front-end Electronic

- Preamplifier, drivers, cables, connectors: **257k€**
- LV power supply: **27k€**

□ Totale: **359k€**



The End